

UM11503

KITFS26AEEVM evaluation board

Rev. 1 — 29 January 2021

User manual



Figure 1. KITFS26AEEVM

Important Notice

NXP provides the enclosed product(s) under the following conditions:

This evaluation kit is intended for use of ENGINEERING DEVELOPMENT OR EVALUATION PURPOSES ONLY. It is provided as a sample IC pre-soldered to a printed circuit board to make it easier to access inputs, outputs, and supply terminals. This evaluation board may be used with any development system or other source of I/O signals by simply connecting it to the host MCU or computer board via off-the-shelf cables. This evaluation board is not a Reference Design and is not intended to represent a final design recommendation for any particular application. Final device in an application will be heavily dependent on proper printed circuit board layout and heat sinking design as well as attention to supply filtering, transient suppression, and I/O signal quality.

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1 Introduction

This document is the user guide for the KITFS26AEEVM evaluation board. This document is intended for the engineers involved in the evaluation, design, implementation, and validation of FS2600 Fail-safe system basis chip with multiple SMPS and LDO.

The scope of this document is to provide the user with information to evaluate the FS2600 Fail-safe system basis chip with multiple SMPS and LDO. This document covers connecting the hardware, installing the software and tools, configuring the environment and using the kit.

It is delivered with empty OTP content in order to leave the opportunity to the user to burn the OTP configuration. The board contains a superset device (PFS2630AMDA0AD), allowing tests on all the FS26 derivatives.

2 Finding kit resources and information on the NXP web site

NXP Semiconductors provides online resources for this evaluation board and its supported device(s) on <http://www.nxp.com>.

The information page for KITFS26AEEVM evaluation board is at <http://www.nxp.com/KITFS26AEEVM>. The information page provides overview information, documentation, software and tools, parametrics, ordering information and a **Getting Started** tab. The **Getting Started** tab provides quick-reference information applicable to using the KITFS26AEEVM evaluation board, including the downloadable assets referenced in this document.

2.1 Collaborate in the NXP community

The NXP community is for sharing ideas and tips, ask and answer technical questions, and receive input on just about any embedded design topic.

The NXP community is at <http://community.nxp.com>.

3 Getting ready

Working with the KITFS26AEEVM requires the kit contents, additional hardware and a Windows PC workstation with installed software.

3.1 Kit contents

- Assembled and tested evaluation board and preprogrammed FRDM-KL25Z microcontroller board in an anti-static bag
- 3.0 ft USB-STD A to USB-B-mini cable
- Two connectors, terminal block plug, 2 pos., str. 3.81 mm
- Three connectors, terminal block plug, 3 pos., str. 3.81 mm
- Jumpers mounted on board

3.2 Additional hardware

In addition to the kit contents, the following hardware is necessary or beneficial when working with this kit.

- Power supply with a range of 8.0 V to 40 V and a current limit set initially to 1.0 A

3.3 Windows PC workstation

This evaluation board requires a Windows PC workstation. Meeting these minimum specifications should produce great results when working with this evaluation board.

- USB-enabled computer with Windows 7 or Windows 10

3.4 Software

Installing software is necessary to work with this evaluation board.

- NXP GUI installation package

4 Getting to know the hardware

The KITFS26AEEVM provides flexibility to play with all the features of the device and make measurements on the main part of the application. The FRDM-KL25Z connected to the board, combined with the FS26 NXP GUI software allows full configuration and control of the FS26 SBC.

4.1 Kit overview

The FS26 family can be evaluated with this board as it is populated with a superset part. The FS26xx part soldered on the board can be fused one time or it is possible to test as many configurations as needed in Emulation mode.

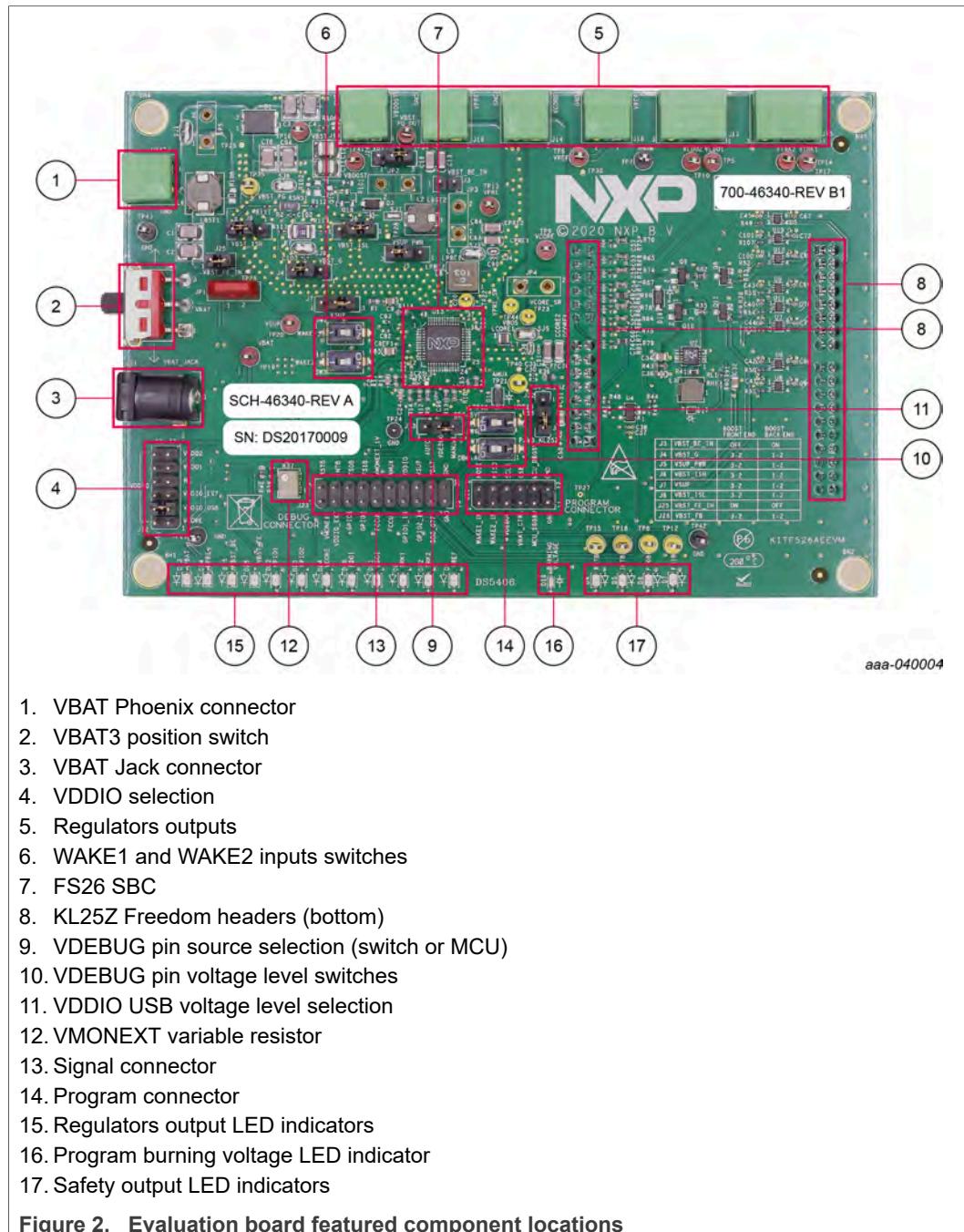
This board was designed to sustain up to 2.0 A total on VPREG. Layout is done using six-layer PCB stack up. Set initial current limitation of 1 A.

4.1.1 KITFS26AEEVM features

- VBAT power supply connectors (Jack and Phoenix)
- VPREG output capability up to 2.0 A
- VBOOST in independent mode or in front-end topology to support battery cranking profiles
- VCORE up to 1.5 A peak
- LDO1 and LDO2 from 3.3 V or 5.0 V, up to 400 mA
- VTRK1 and VTRK2, from 3.3 V or 5.0 V, up to 125 mA
- VREF 1 % accuracy regulator for external ADC reference
- FS0B, FS1b external safety pins
- USB to SPI protocol for easy connection to software GUI
- LEDs that indicate signal or regulator status
- Manual or Automated OTP fuse programming
- Advance system monitoring via AMUX or external ADC
- Analog variable resistor to test external VMON

4.2 Kit featured components

[Figure 2](#) identifies important components on the board.



4.2.1 FS26: Safety system basis chip with low power and fit for ASIL D

The FS26 is a family of automotive Safety SBC devices with multiple power supplies, designed to support entry and mid-range safety microcontrollers like the S32K3 series while maintaining flexibility to fit other microcontrollers targeting automotive electrification such as power train, chassis, safety and low-end gateway applications.

This family of devices is composed of several versions, pin to pin and software compatible, to support a wide range of applications, offering choice in number of output rails, output voltage setting, operating frequency, power up sequencing, and integrated

system level features to address multiple applications with Automotive Safety Integrity Levels (ASIL) B or D.

It features multiple switch mode regulators as well as LDO voltage regulators to supply the microcontroller, sensors, peripheral ICs, and communication interface. It offers a high precision voltage reference available to the system as well as reference voltage for two independent voltage tracking regulators as well as various functionalities for system control and diagnostics such as Analog multiplexer, GPIOs and selectable wake up events from I/O, long duration timer or SPI communication.

The FS26 is developed in compliance with the ISO 26262 standard, and it includes enhanced safety features, with multiple fail-safe outputs, becoming a full part of a safety-oriented system partitioning, covering both ASIL B and ASIL D safety integrity level, with the latest on-demand latent fault monitoring.

Operating range

- 40 V DC maximum input voltage
- Handles severe cranking operation (3.2 V battery) thanks to its BOOST controller
- Supports operating voltage range down to battery 6.0 V without BOOST
- Low-power Off mode with very low sleep current (50 μ A typ)
- Low-power Standby mode, VPREG active
- LDO1 or LDO2 active selectable via OTP configuration (50 μ A typ)

4.2.2 VBAT connectors

There are two ways of supplying the board: either by a Phoenix Connector (J2) or a Jack connector (J2). The selection of the supplying connector is done using a three-position switch (SW1).

[Figure 3](#) shows related schematic. Nominal VBAT voltage is 12 V and can support up to 40 V.

Table 1. VBAT Phoenix connector (J1)

Schematic label	Signal name	Description
J1-1	VBAT	Battery voltage supply input
J1-2	GND	Ground

Table 2. VBAT three position connector (SW1)

Schematic label	Signal name	Description
SW1 pin 2-3	VBAT Phoenix	Board supplied by Phoenix connector
SW1 pin 2 (middle position)	VBAT	Board not supplied
SW1 pin 2-1	VBAT jack	Board supplied by Jack connector

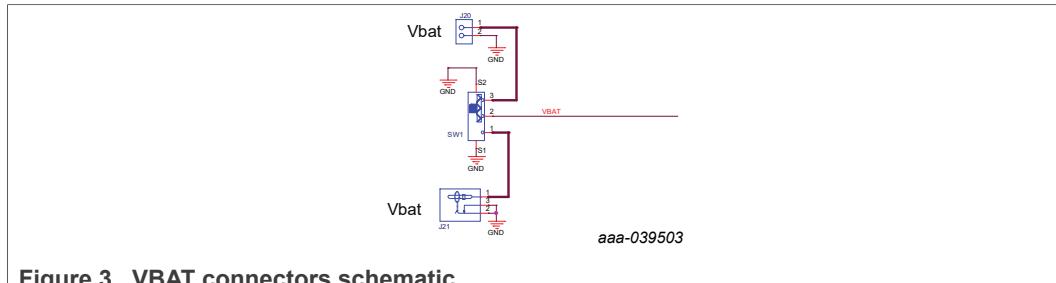


Figure 3. VBAT connectors schematic

4.2.3 Power topology configuration

There are two power topologies available depending on the application and OTP configuration. The device can be supplied directly by the battery after diode and pi filter; on the other side, the boost regulator can be connected in front-end topology to support cold cranking profiles.

It is possible to evaluate both power topologies with this board since external boost components for each topology are soldered separately as shown in [Figure 4](#).

A set of jumper configurations allows you to select between the two options. See [Figure 5](#) and [Table 3](#). Default jumper configuration is boost in front-end topology.

In front-end topology boost is connected to the battery after reverse diode; the output of the boost supplies the device during cold cranking profiles. Otherwise, boost stops switching, and it is bypassed. See FS26 data sheet for more information.

In back-end topology or independent boost, the device is supplied by the battery, and the boost is supplied by the buck regulator VPREG.

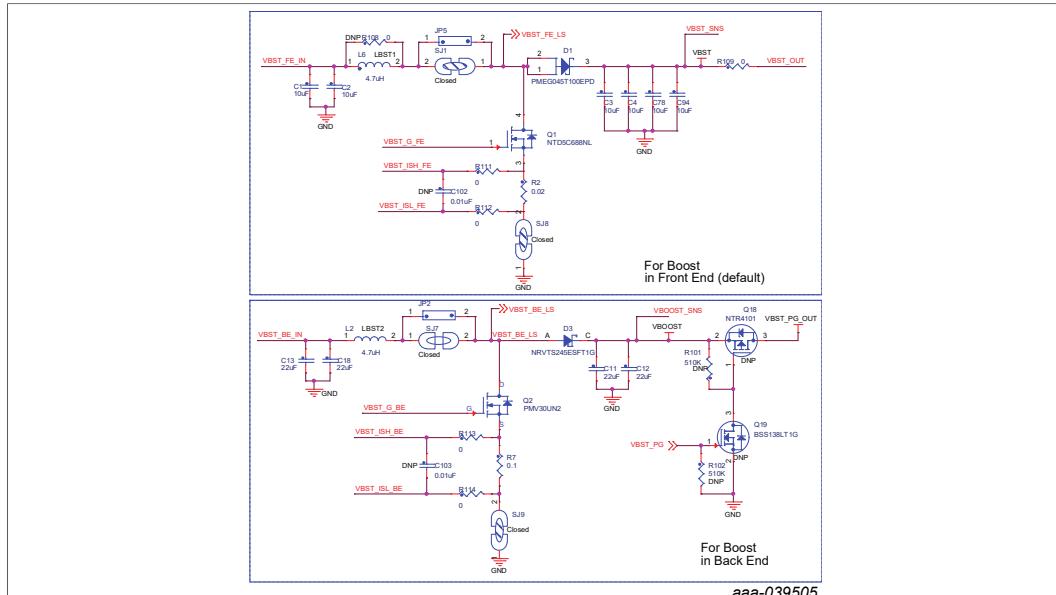


Figure 4. Schematic of boost external components for front end and back-end topologies

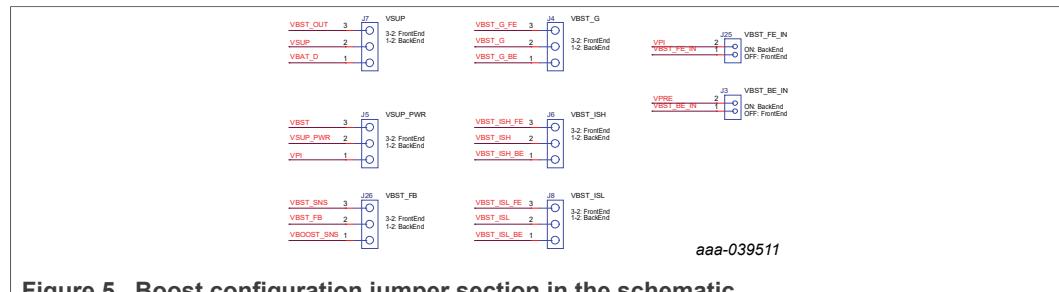


Figure 5. Boost configuration jumper section in the schematic

Table 3. Jumper configuration for front end and back-end power topologies

Schematic label	Signal name	BOOST front-end (default positions)	BOOST back-end
J3	VBST_BE_IN	OFF	ON
J4	VBST_G	3-2	1-2
J5	VSUP_PWR	3-2	1-2
J6	VBST_ISH	3-2	1-2
J7	VSUP	3-2	1-2
J8	VBST_ISL	3-2	1-2
J25	VBST_FE_IN	ON	OFF
J26	VBST_FB	3-2	1-2

Figure 6 shows a simplified diagram of jumper configuration to associated device pins.

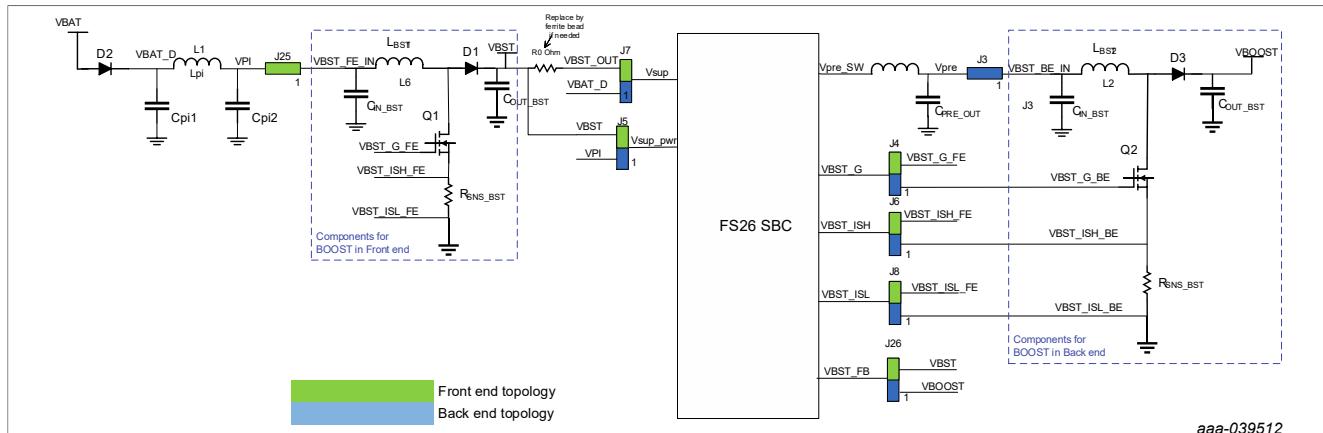


Figure 6. Simplified diagram of jumper configuration for front-end and back-end topologies

When testing the FS26 SBC with a front-end configuration at very low battery level and loading product at its maximum rating, make sure that the power supply is capable of providing at least 4.0 A.

4.2.4 Output power supply connectors

Output regulators are accessible through test points or Phoenix connectors in order to make measurement or plug loads. Male connectors are included on this kit to plug or unplug wires easily. All output regulators are located at the top edge of the board as shown in [Figure 2](#).

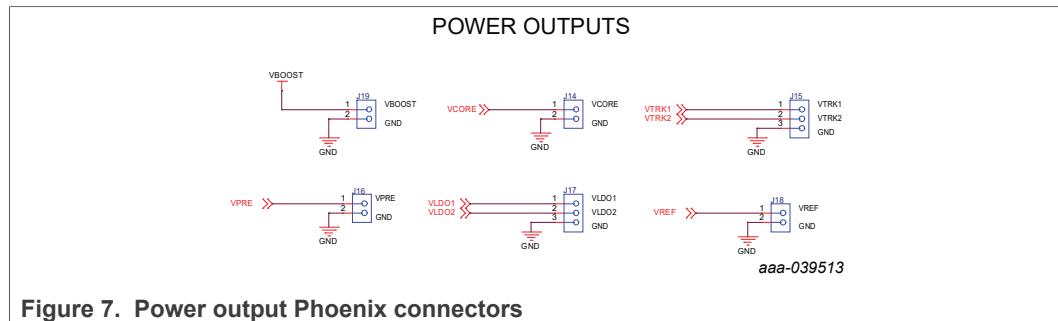


Figure 7. Power output Phoenix connectors

Table 4. VCORE connector (J14)

Schematic label	Signal name	Description
J16-1	VCORE	VCORE power supply output
J16-2	GND	Ground

Table 5. VTRK1/VTRK2 connector (J15)

Schematic label	Signal name	Description
J15-1	VTRK1	VTRK2 power supply output
J15-2	VTRK2	VTRK1 power supply output
J15-3	GND	Ground

Table 6. VPRE connector (J16)

Schematic label	Signal name	Description
J16-1	VPRE	VPRE power supply output
J16-2	GND	Ground

Table 7. VLDO1/VLDO2 connector (J17)

Schematic label	Signal name	Description
J17-1	LDO1	LDO1 power supply output
J17-2	LDO2	LDO2 power supply output
J17-3	GND	Ground

Table 8. VREF connector (J18)

Schematic label	Signal name	Description
J18-1	VREF	VREF reference output
J18-2	GND	Ground

Table 9. VBOOST connector (J19)

Schematic label	Signal name	Description
J19-1	VBOOST	VBOOST power supply output

Table 9. VBOOST connector (J19)...continued

Schematic label	Signal name	Description
J19-2	GND	Ground

4.2.5 Signal and program connectors

Signal and program connectors allow access to most of the device signals in order to program the device externally or to perform debug and diagnosis.

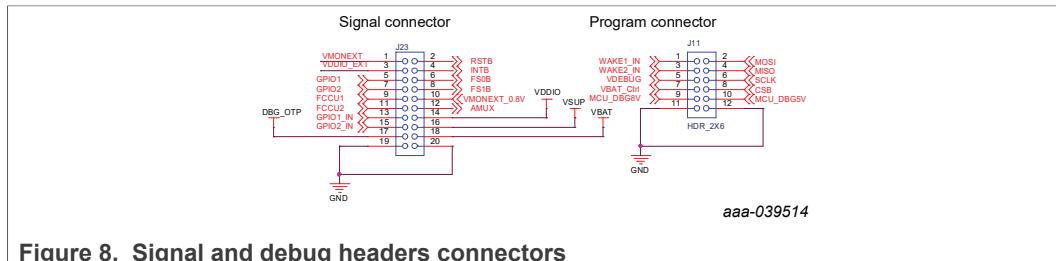


Figure 8. Signal and debug headers connectors

Table 10. Program connector (J11)

Schematic label	Signal name	Description
J11_1	WAKE1_IN	WAKE1 input access
J11_2	MOSI	MOSI signal access
J11_3	MISO	MOSI signal access
J11_4	WAKE2_IN	WAKE2 input access
J11_5	VDEBUG	VDEBUG pin
J11_6	SCLK	SCLK signal access
J11_7	VBAT_Ctrl	VBAT_Ctrl KL25Z output access; to control VBAT power by MCU, JP1 must be OFF
J11_8	CSB	CSB signal access
J11_9	MCU_DBG8V	MCU_DBG8V KL25Z output access
J11_10	MCU_DBG5V	MCU_DBG5V KL25Z output access
J11_11	GND	GND
J11_12	GND	GND

Table 11. Signal connector (J23)

Schematic label	Signal name	Description
J23_1	VMONEXT	External monitoring, resistor bridge side
J23_2	RSTB	RSTB IC safety output
J23_3	VDDIO_EXT	Optional external supply for VDDIO, make sure that there is a jumper between J12 5-6 pins
J23_4	INTB	INTB interruption output
J23_5	GPIO1	GPIO1 IC side, for signal access; disconnect R87 before use as an output
J23_6	FS0B	FS0B IC safety output
J23_7	GPIO2	GPIO2 IC side, for signal access; disconnect R87 before use as an output
J23_8	FS1B	FS1B IC safety output

Table 11. Signal connector (J23)...continued

Schematic label	Signal name	Description
J23_9	FCCU1	FCCU1
J23_10	VMONEXT_0.8V	VMONEXT IC side, for access or disconnect R39 to apply 0.8 V externally
J23_11	FCCU2	FCCU2
J23_12	AMUX	AMUX pin read
J23_13	GPIO1_IN	GPIO1 input side
J23_14	VDDIO	VDDIO IC side access
J23_15	GPIO2_IN	GPIO2 input side
J23_16	VSUP	VSUP pin access
J23_17	DBG OTP	DBG OTP power supply (8.0 V) access
J23_18	VBAT	VBAT access
J23_19	GND	GND
J23_20	GND	GND

4.2.6 Indicators

The LED indicators on the board display VBAT regulators, safety outputs, and GPIO status. For VBAT, regulators and GPIOs there are green LEDs indicating that the output is powered on. The power supply of these indicators is usually VPRE, and it is controlled by a low voltage MOSFET by the corresponding signal or regulator.

These regulators can be turned Off manually at any time with the switch SW4 in order to avoid undesired losses and obtain more accurate current consumption measurements.

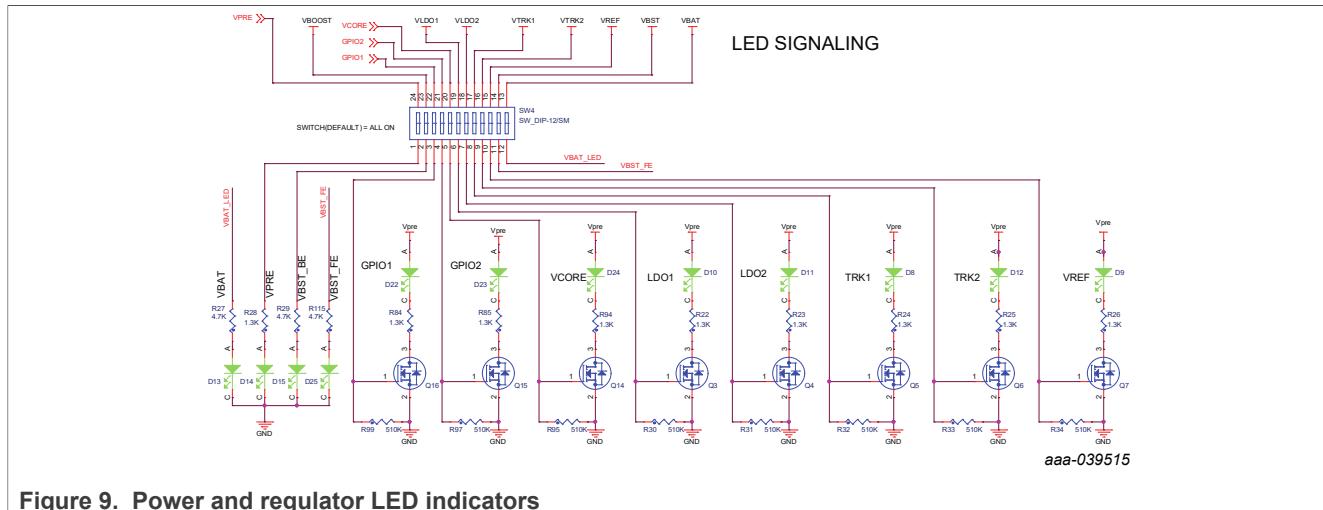


Figure 9. Power and regulator LED indicators

The color of the safety output LED indicators is red. When the safety output is asserted, LED indicators are turned On and Off when the safety output is released. LEDs can also be disabled using switch SW5.

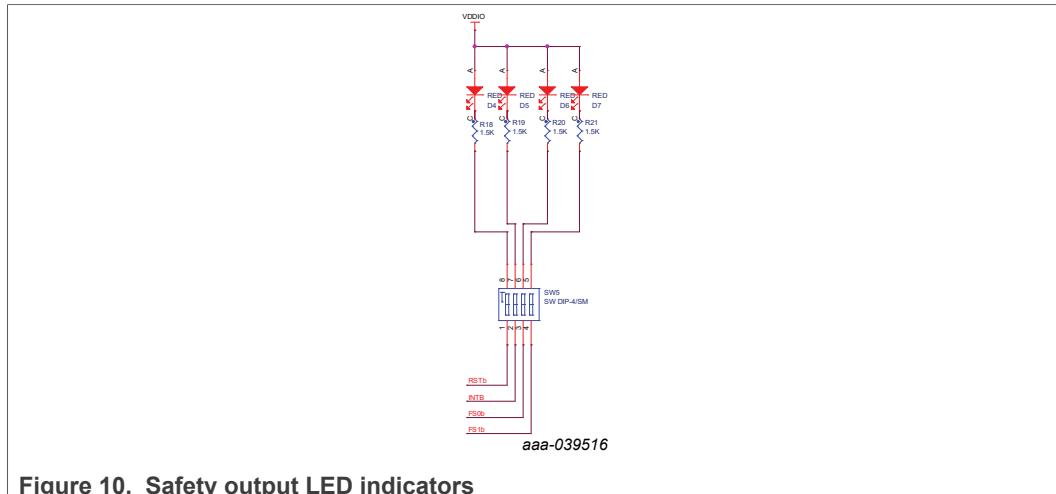


Figure 10. Safety output LED indicators

4.2.7 Test points

The KITFS26AEEVM evaluation board has several test points for easy access and measurements. The test points are color coded, and can be different part numbers or without a part number, as shown in [Figure 11](#).

- Orange: test loop access to safety outputs and analog signals
- Red: test loop access for power supplies
- Black: test loop access to GND
- Blue: not a part; through hole small test points on board close to the signal

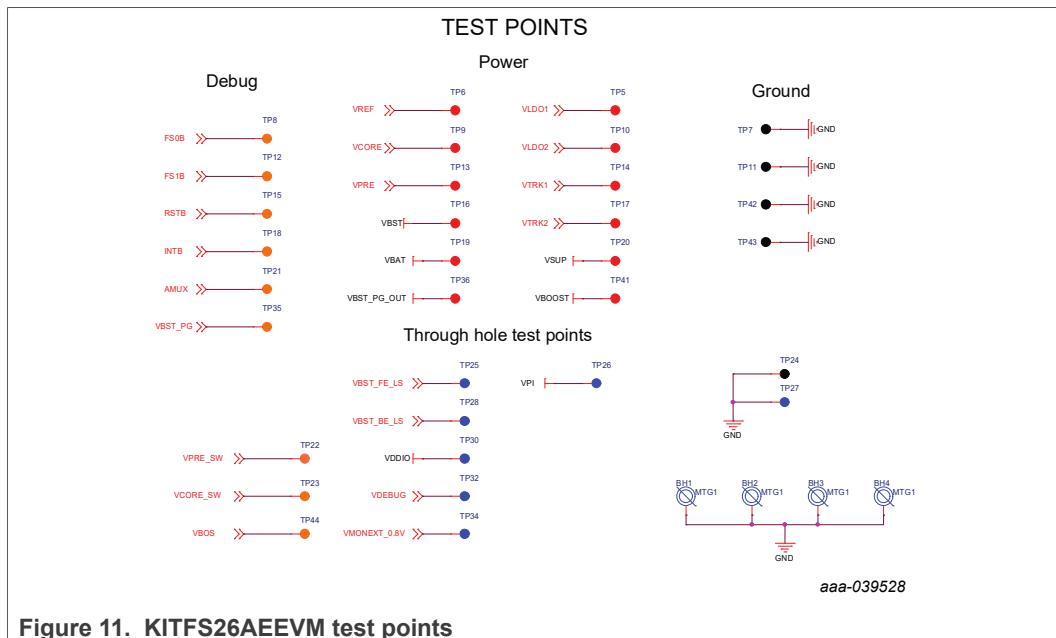


Figure 11. KITFS26AEEVM test points

4.2.8 VDDIO selection

VDDIO reference can be supplied by 3.3 V or 5.0 V depending on the system. The supply can be generated on the board, from a voltage regulator, or from an external source.

J12 allows selection of the supply source, as shown in [Table 12](#).

Table 12. VDDIO connector (J12)

Schematic label	Signal name	Description
J12_1-2	VCORE	VDDIO supply is VCORE
J12_3-4 (default)	VDDIO_USB	VDDIO supply is VDDIO_USB (J22_2)
J12_5-6	VDDIO_EXT	VDDIO supply is VDDIO_EXT (J23_3)
J12_7-8	NC	VDDIO Not connected
J12_9-10	VLDO1	VDDIO supply is VLDO1
J12_11-12	VLDO2	VDDIO supply is VLDO2

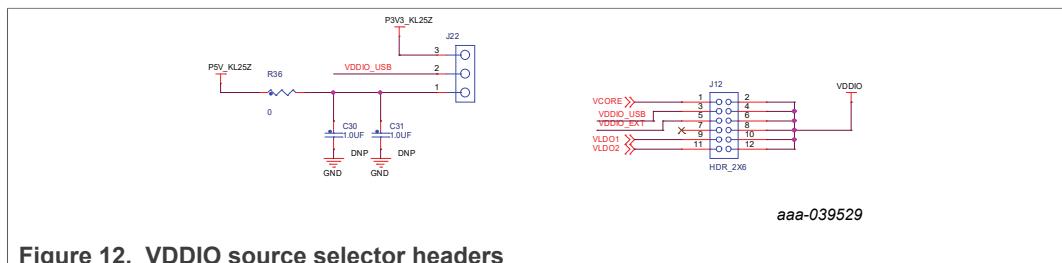


Figure 12. VDDIO source selector headers

4.2.9 Wake input switches

Wake inputs can be exercised by switches SW2 for WAKE1_IN and SW3 for WAKE2_IN. These interrupts are supplied by the battery to VBAT signal.

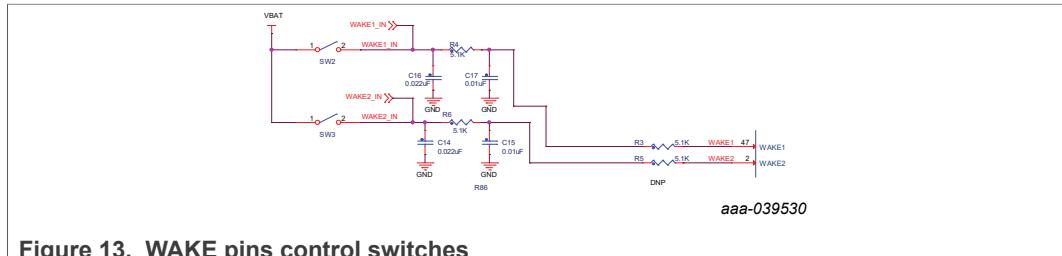


Figure 13. WAKE pins control switches

4.2.10 VDEBUG pin voltage control

VDEBUG pin allows FS26 SBC to enter the different operating modes to perform debug or programming by applying different voltage thresholds or sequences. These thresholds can be generated on the board and debug pin can be controlled manually or fully automated by KL25Z.

The selection for manual (default) or automatic is done by J13.

Table 13. Debug control selector (J13)

Schematic label	Signal name	Description
J13_1-2	Manual (default)	Debug thresholds are control by SW6 and SW7
J13_2-3	Automatic (feature not enabled)	Debug thresholds are controlled by KL25Z

Different voltage levels and sequences can be used to enter Debug mode; emulate an OTP configuration, or burn an OTP configuration to the fuses. The threshold levels are:

- **VDEBUG < VDBG4TH (VDEBUG < 4.2 V)**: waive debug entry at power up or after low-power modes exit.
- **VDEBUG > VDBG4TH (VDEBUG > 4.2 V)**: enter debug mode at power up or after low-power modes exit.
- **VDEBUG VDBG65TH (VDEBUG > 6.9 V)**: burning level for OTP programming.

The power supply to generate the debug entry voltage threshold comes from KL25Z USB. This means that Freedom board and USB must be plugged in. Burning voltage for OTP is generated by an onboard boost IC that is also powered by FRDM-KL25Z.

For manual mode, use SW6 to allow connection to 5.0 V power supply, and SW7 to connect to 8.0 V power supply; when VDBG65TH is reached a blue LED (D19) turns On. [Table 14](#) shows the possible output voltage level to apply to VDebug pin depending on SW6 and SW7 positions.

Table 14. SW6 and SW7 VDebug output configuration

SW6	SW7	VDebug (J13-2) voltage level
OFF	OFF	0 V
OFF	ON	7.8 V
ON	OFF	4.5 V
ON	ON	7.8 V

When automatic mode is selected on connector J13 and KL25Z is plugged in and used, 5.0 V and 8.0 V thresholds can be controlled on the NXP GUI by KL25Z signals. It is also possible to control VBAT by a MCU signal to generate automated sequences for program and emulations; these signals are:

VBAT_Ctrl: Open or close VBAT power supply

MCU_DBG5V: 5.0 V on VDEBUG pin

MCU_DBG8V: 8.0 V on VDEBUG pin

Debug mode entry

To enter debug mode, follow the sequence:

1. VBAT Off (SW1)
2. VDebug (J13) > VDBG4TH
3. VBAT On (SW1)
4. At this step Debug mode is enabled and you can emulate an OTP configuration or access the SPI register map. You can read FS_STATES register to verify you are in Debug mode.

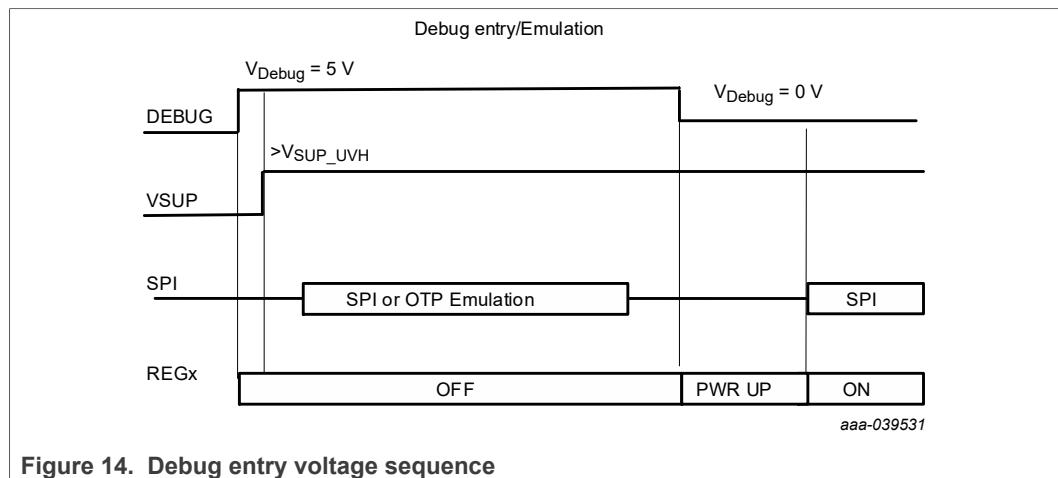


Figure 14. Debug entry voltage sequence

OTP programming

To burn an OTP configuration on the fuses permanently, the following sequence must be applied. More detailed instructions are provided in [Section 8.5 "Program an OTP configuration".](#)

1. VBAT OFF (SW1)
2. VDebug (J13) > VDBG4TH (SW6 On).
3. VBAT On (SW1)
4. At this step, Debug mode is enabled and you can emulate an OTP configuration or access the SPI register map. You can read FS_STATES register to verify you are in Debug mode.
5. VDebug (J13) > VDBG65TH (SW7 On). If the threshold is applied, D19 blue LED turns On.
6. Load an OTP configuration file and wait until all commands are sent.
7. Put VDebug (J13) to 0 V (first SW7, and then SW6).
8. The device should power up with selected OTP configuration or you can restart the device power supply to load the burned OTP configuration from fuses.

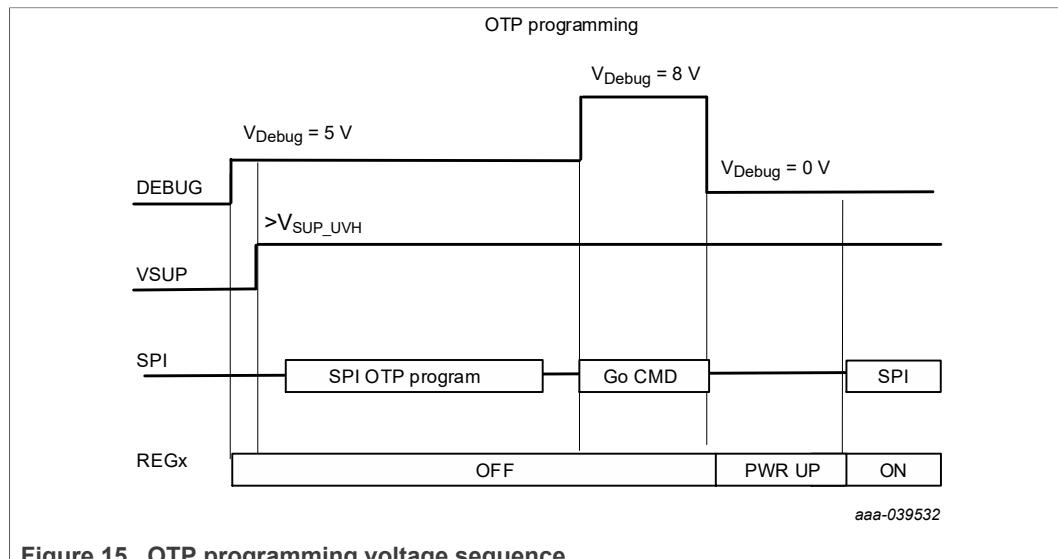


Figure 15. OTP programming voltage sequence

[Figure 16](#) shows the VDebug voltage sources and its selection.

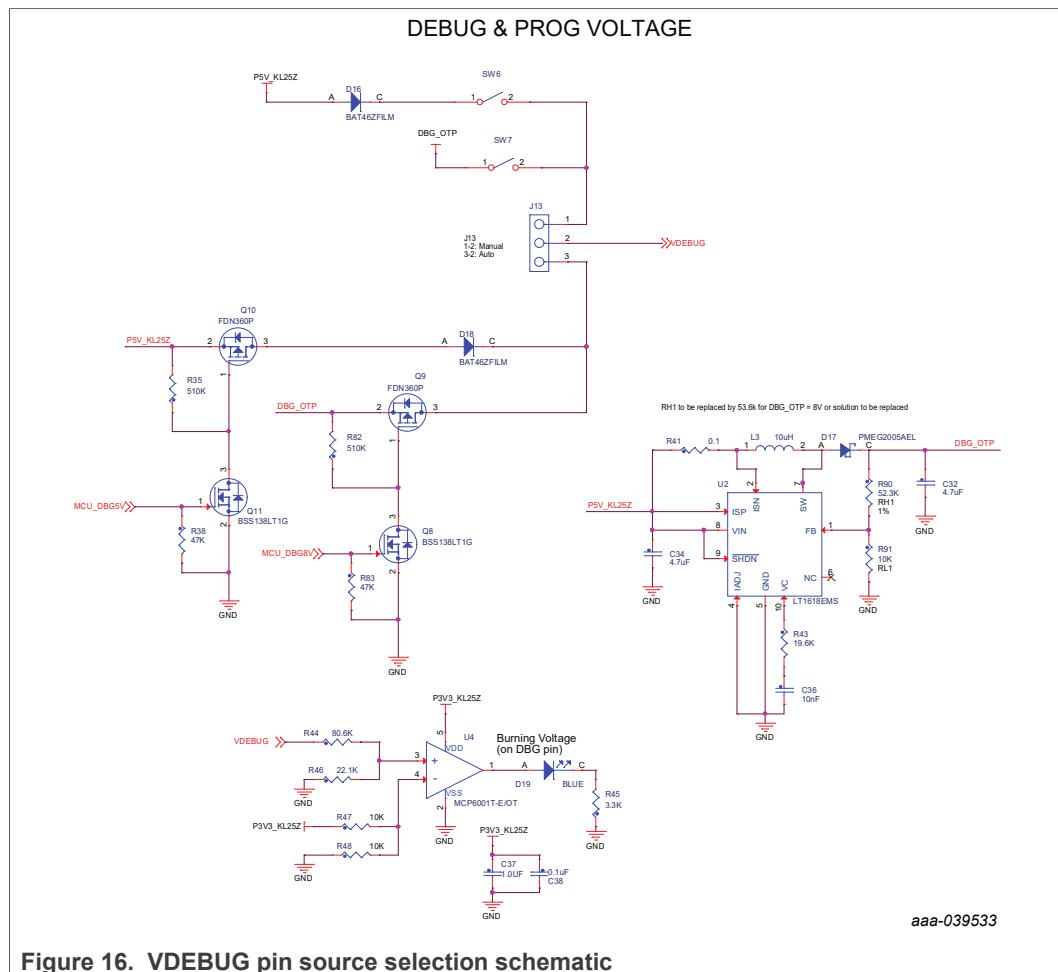


Figure 16. VDEBUG pin source selection schematic

4.2.11 VMONEXT monitoring

FS26 VMONEXT monitoring pin can be accessed in different ways. If used, VMONEXT value should always be 0.8 V. VMONEXT signal can be supplied by any source or regulator and VMONEXT_0.8V value can be adjusted by using a screwdriver on R37 potentiometer. Default bridge resistor is 22.2 k Ω .

To apply 0.8 V directly to VMONEXT_0.8V, remove R39 and apply 0.8 V to connector J23_1.

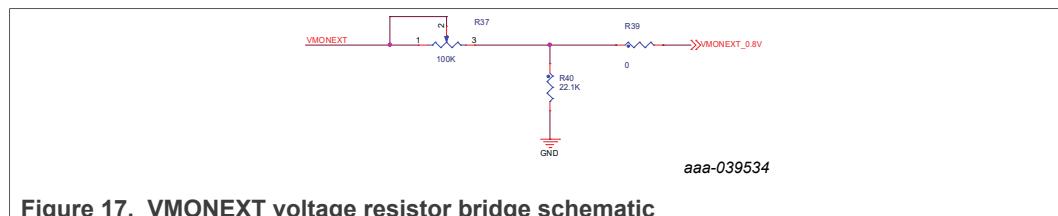


Figure 17. VMONEXT voltage resistor bridge schematic

4.2.12 GPIO1 and GPIO2

GPIO1 and GPIO2 FS26 pins are connected by default as outputs, and can be accessed by J23 connector.

- J23_5 for GPIO1

- J23_7 for GPIO2

To exercise GPIO pins as inputs, R87 and R89 must be populated in order to apply voltage before RC filter. GPIO input supply can be applied through J23 header.

- GPIO1_IN can be accessed through J23_13; R87 must be populated.
- GPIO2_IN can be accessed through J23_15; R89 must be populated.

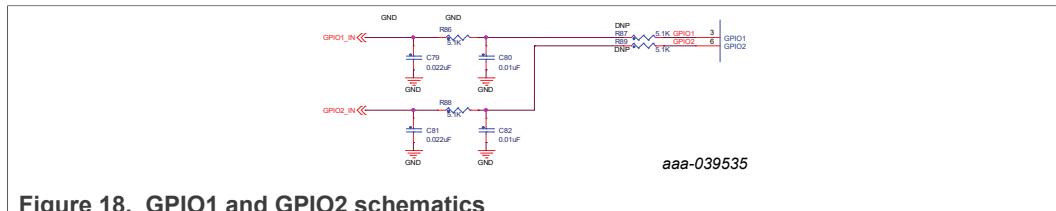


Figure 18. GPIO1 and GPIO2 schematics

Note: There are no external pull-ups or pull-downs for the GPIO. If the internal pull-ups or pull-downs are not enabled by OTP, external PU/PD can be added through J23.

4.3 Schematic, board layout and bill of materials

The schematic, board layout and bill of materials for the KITFS26AEEVM evaluation board are available at <http://www.nxp.com/KITFS26AEEVM>.

5 Installing and configuring software and tools

5.1 Flashing or updating the GUI firmware

The KITFS26AEEVM is delivered with the GUI firmware flashed. If MCU firmware is flashed, ignore this section. If it is specified to update the firmware or it is malfunctioning, follow the instructions in [Section 5.1.1 "Flashing Freedom board firmware for Windows 7"](#) and [Section 5.1.2 "Flashing Freedom board firmware from Windows 10"](#).

5.1.1 Flashing Freedom board firmware for Windows 7

Steps 1 and 2 are not required if BOOTLOADER is already loaded in the Freedom board.

1. Press the RST push-button and connect the USB cable into the SDA port on the Freedom board.
 - A new “BOOTLOADER” device should appear on the left pane of the File explorer.
2. Drag and drop the file “MSD-DEBUG-FRDM-KL25Z_Pemicro_v118.SDA” into the BOOTLOADER drive.

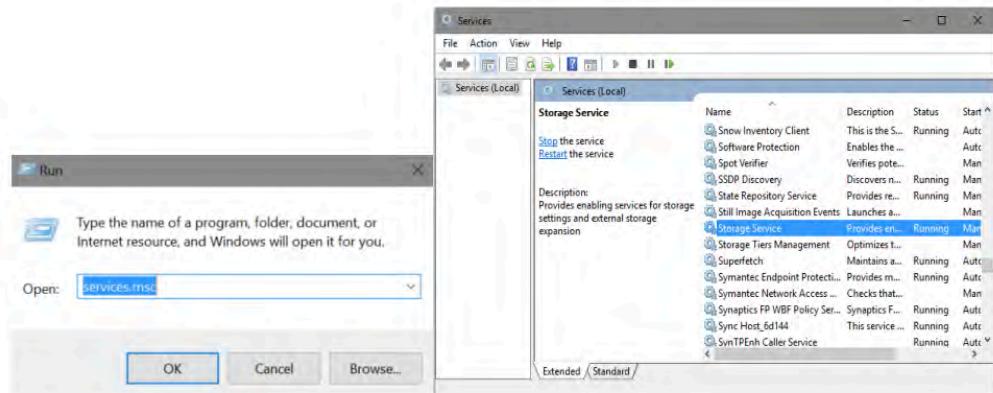
Note: Make sure to allow enough time for the firmware to be saved in the Bootloader.
3. Disconnect and reconnect the USB cable into the SDA port.
 - This time without pressing the RST push-button, FRDM_KL25Z device should appear on the left pane of the File explorer.



4. Locate the file “nxp-gui-fw-frdmkl25z-usb_hid-fs2630_vX.Y.bin” from the package and drag and drop the file into the FRDM_KL25Z device.
Note: Make sure to allow enough time for the firmware to be saved.
5. Freedom board firmware is successfully loaded. Disconnect and reconnect the USB cable into the KL25Z USB port.

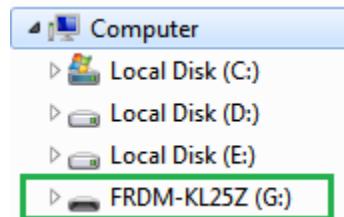
5.1.2 Flashing Freedom board firmware from Windows 10

1. Disable the storage services: run the services, double-click on the storage service from the list and press **STOP**.



Steps 2 and 3 are not required if BOOTLOADER is already loaded in the Freedom board.

2. Press the RST push-button and connect the USB cable into the SDA port on the Freedom board.
 - a. A new “BOOTLOADER” device should appear on the left pane of the File explorer.
3. Drag and drop the file “MSD-DEBUG-FRDM-KL25Z_Pemicro_v118.SDA” into the BOOTLOADER drive.
Note: Make sure to allow enough time for the firmware to be saved in the BOOTLOADER.
4. Disconnect and reconnect the USB cable into the SDA port.
 - This time without pressing the RST push-button, FRDM_KL25Z device should appear on the left pane of the File explorer.



5. Locate the file “nxp-gui-fw-frdmkl25z-usb_hid-fs2630_vX.Y.bin” from the package and drag and drop the file into the FRDM_KL25Z device.
Note: Make sure to allow enough time for the firmware to be saved.
6. Freedom board Firmware is successfully loaded. Disconnect and reconnect the USB cable into the KL25Z USB port.

5.2 Installing GUI software package

To install the FS26 NXP GUI, download or obtain the NXP GUI package, unzip 1- **NXP_GUI_Setup** folder:

Name	Status	Date modified	Type	Size
0 - Documentation	✓	6/8/2020 10:57 AM	File folder	
1 - NXP_GUI_Setup	✓	6/8/2020 5:26 PM	File folder	
2 - KL25Z_FW	✓	6/4/2020 1:42 PM	File folder	
LICENSE.txt	✓	6/4/2020 11:14 AM	Text Document	3 KB

Double-click *NXP_GUI_version-Setup.exe* and follow the instructions.

Name	Status	Date modified	Type	Size
NXP_GUI-3.1.45-Setup.exe	✓	6/6/2020 6:55 PM	Application	64,336 KB

Proceed with the following pop-up windows to install the application on Windows PC:

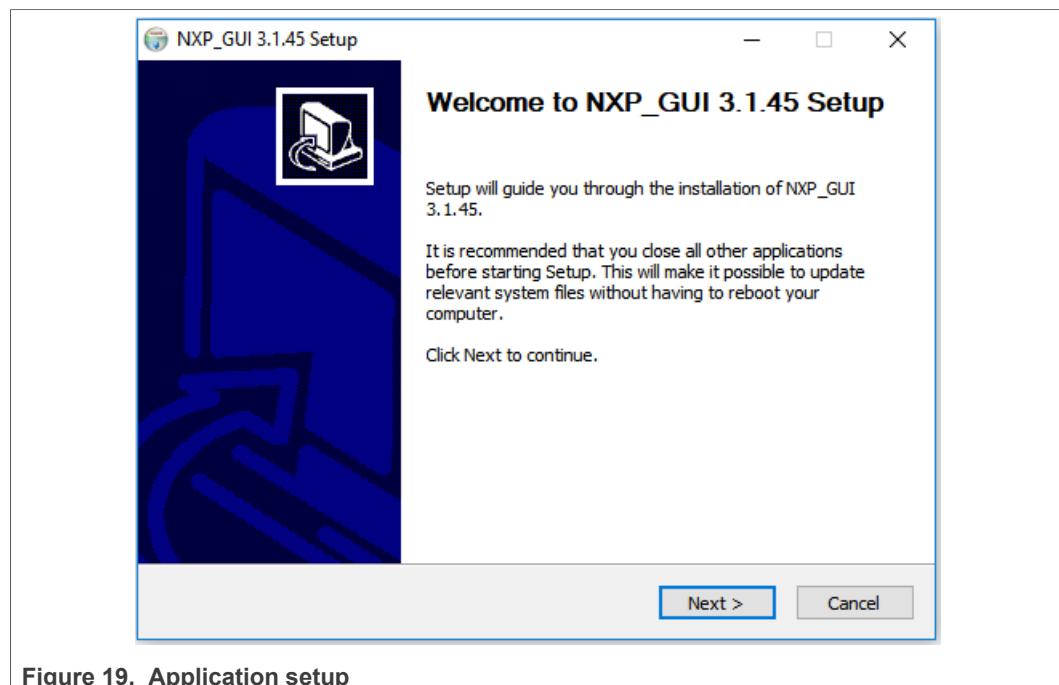


Figure 19. Application setup

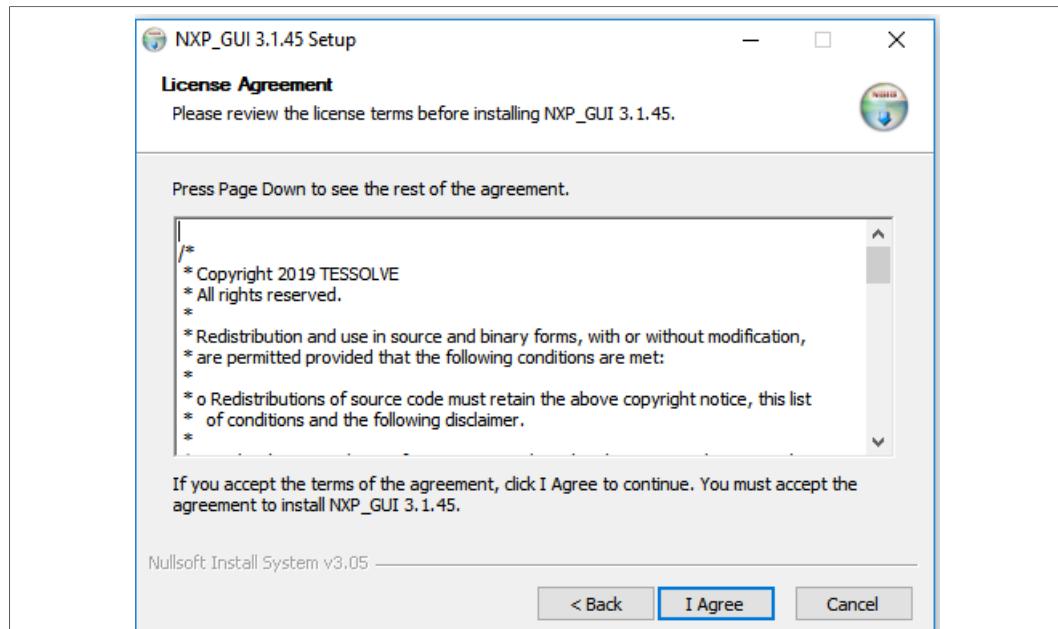


Figure 20. License agreement

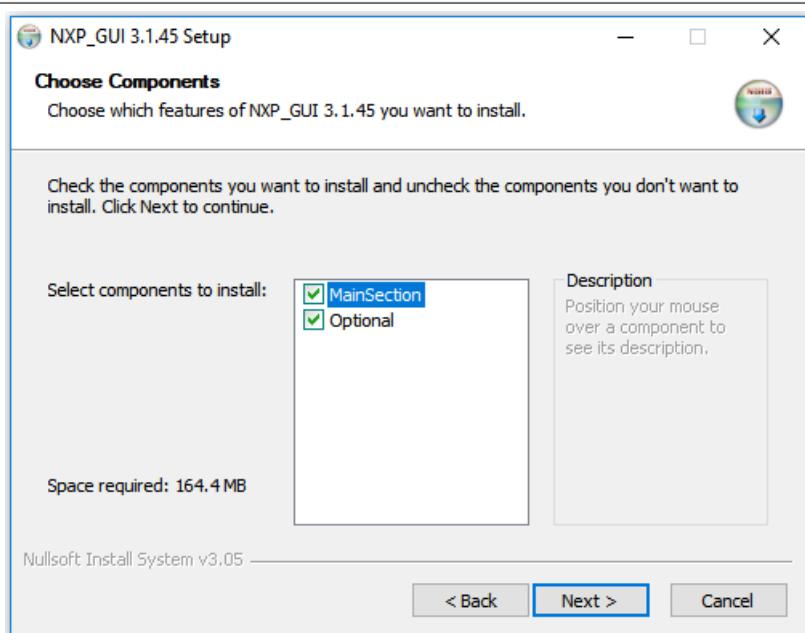


Figure 21. Select FS2630_GUI feature

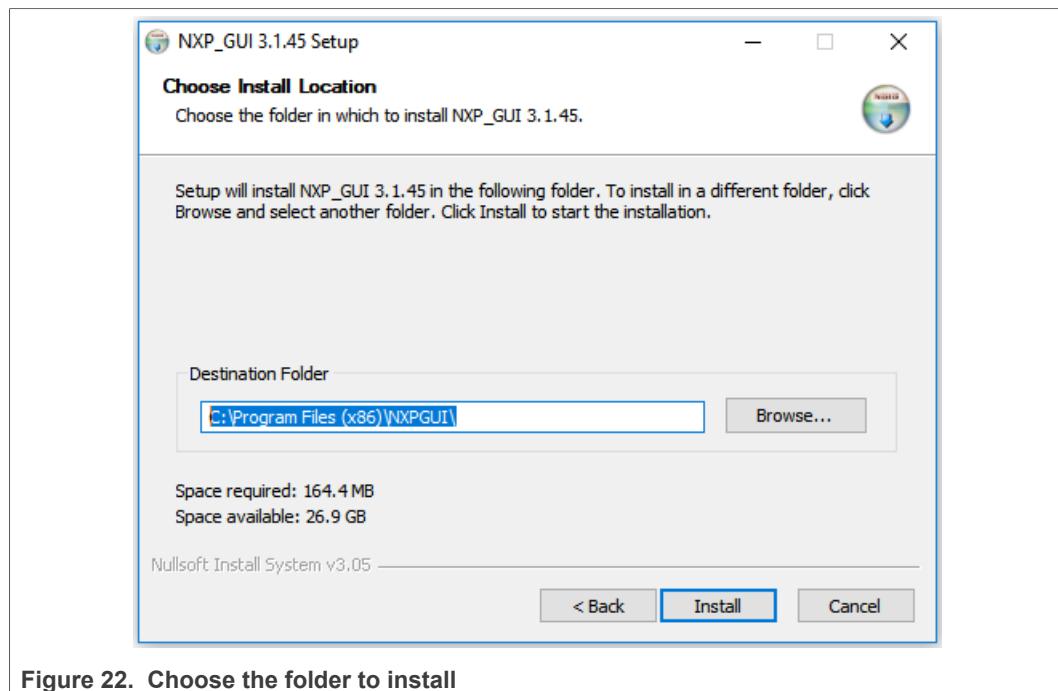


Figure 22. Choose the folder to install

Select the following options before completing the installation of the setup:

- Run NXP_GUI
- Show Readme

Select **Finish** to complete the installation.

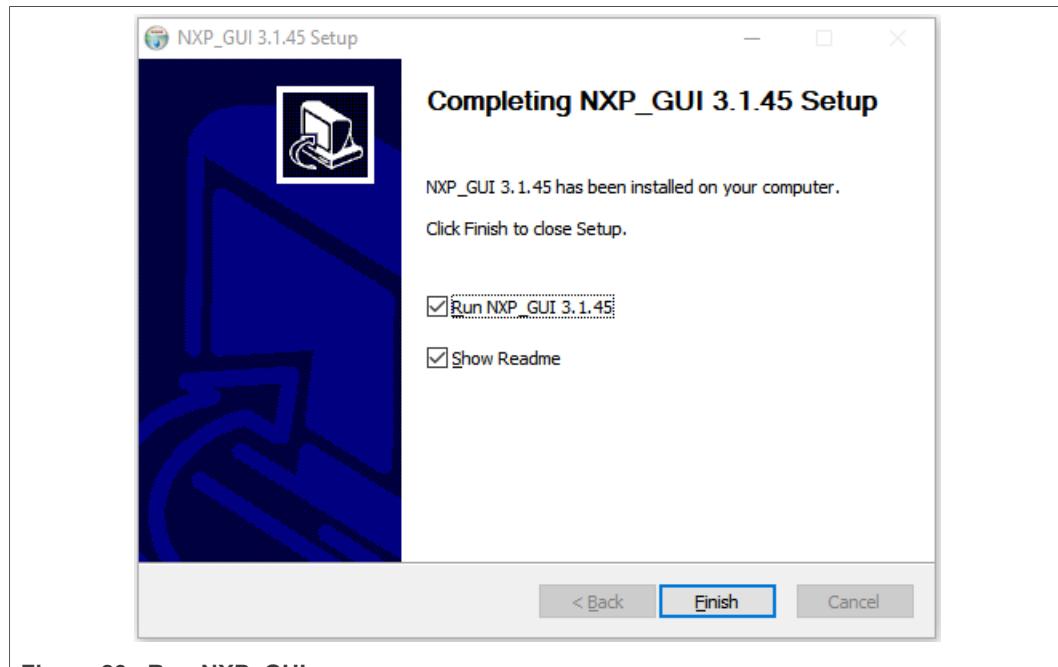


Figure 23. Run NXP_GUI

When installation is finished the application can be found in the windows search bar as "NXPGUI".

6 Configuring the hardware

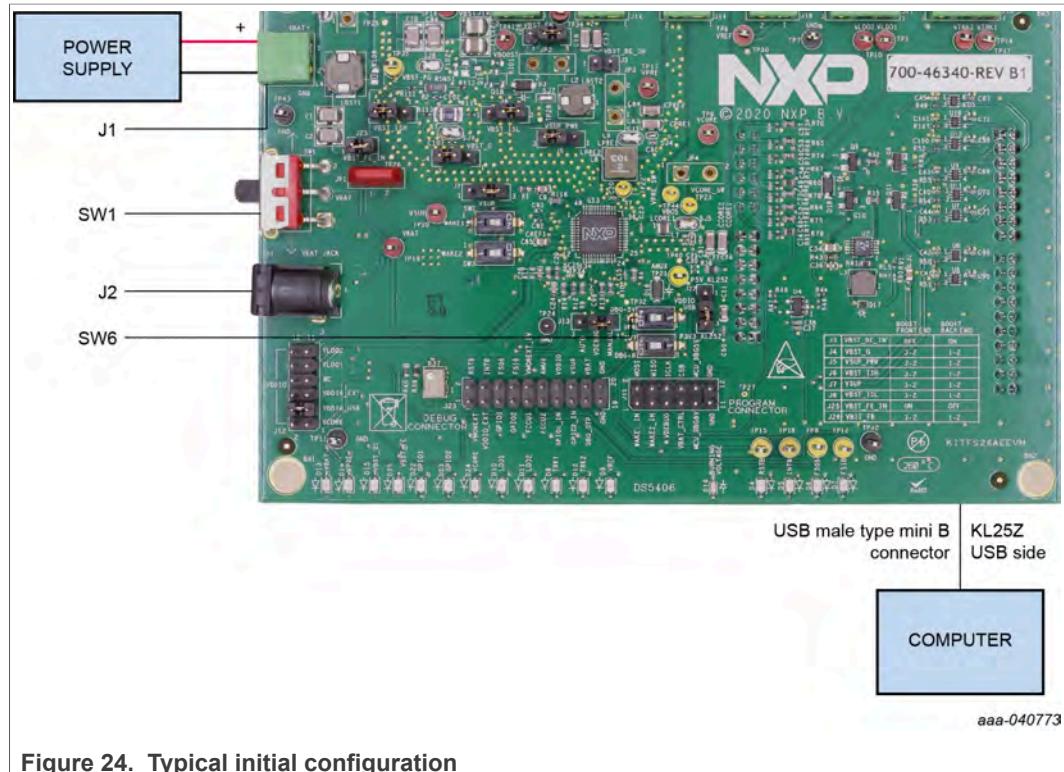


Figure 24. Typical initial configuration

To configure the hardware and workstation, complete the following procedure:

1. With SW1 in middle position, set DC power supply to 12 V and current limit to 1.0 A. Attach the DC power supply positive and negative output to KITFS26AEEVM VBAT Phoenix connector(J1). Or connect 12 V power supply to VBAT Jack (J2).

Table 15. VBAT Phoenix connector (J1)

Schematic label	Signal name	Description
J1-1	VBAT	Battery voltage supply input
J1-2	GND	Ground

Table 16. VBAT three position connector (SW1)

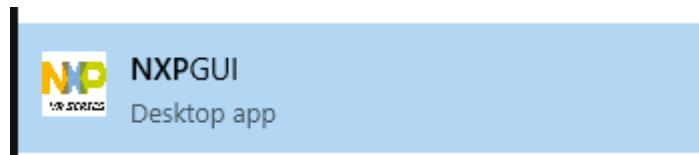
Schematic label	Signal name	Description
SW1 pin 2-3	VBAT Phoenix	Board supplied by Phoenix connector
SW1 pin 2 (middle position)	VBAT	Board not supplied
SW1 pin 2-1	VBAT jack	Board supplied by Jack connector

2. Connect the Windows PC USB port to the KL25Z USB side of the freedom board included in the kit, using the provided USB 2.0 cable.
3. Turn On SW6 to apply 5.0 V to the VDebug pin.
4. Turn On the power supply.
5. Close SW1.

Note: At this step, the product is in debug mode and all regulators are turned Off. The user can then power up with OTP configuration or configure the mirror registers before power up. Power up is effective as soon as SW6 is turned Off.

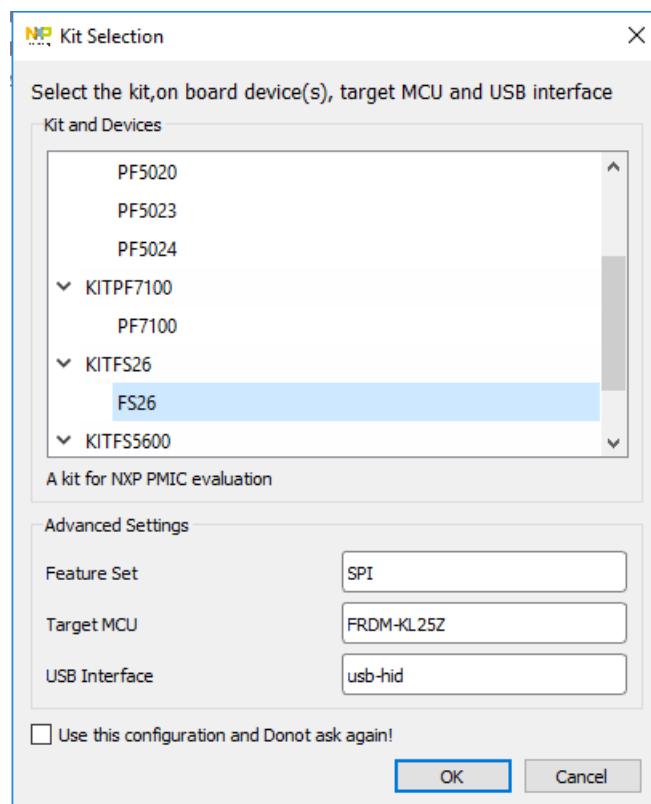
7 FS26 NXP GUI

Once the kit is ready and the NXP GUI is installed, launch the kit from the Windows search bar.



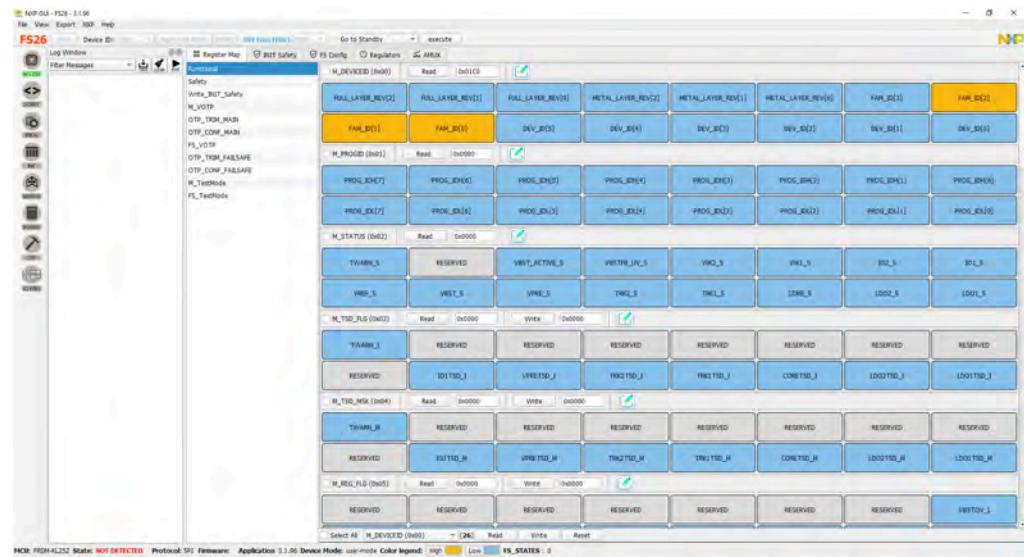
Launching FS26_GUI application

1. When the NXP GUI is launched, the *Kit Selection* window is displayed. Check for the following settings and then select **OK**.

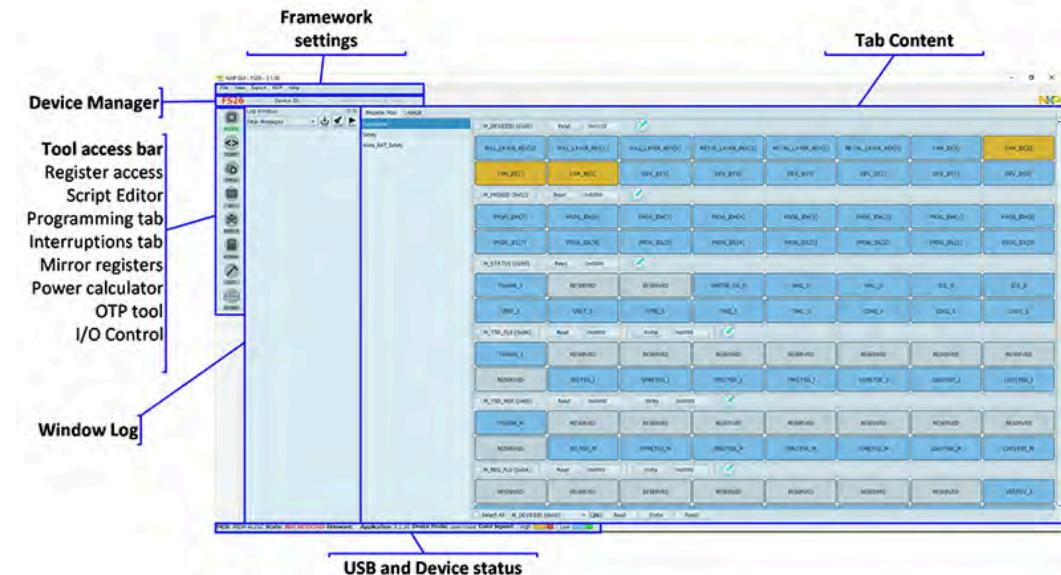


2. To avoid the kit selection window on every launch, select the box "Use this configuration and do not ask again".

The following window is displayed.



7.1 Framework



Device manager: Start communication with device. Enter or exit test mode. Quick access to execute system scripts.

Framework settings: Import or export files, configure framework.

Window log: USB and Device communication events.

USB and device status: Displays if USB or Device is connected or disconnected. Displays firmware and GUI version. Display current state of FS state machine; click **Display** to refresh.

Tool access bar: Quick access to the FS26 evaluation tools and features.

Tab content: Content of each tool or tab; there can be more tabs, boxes, or windows inside.

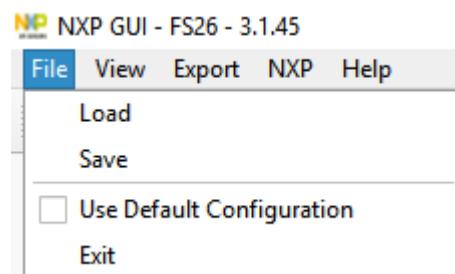
7.1.1 Framework settings

The NXP GUI main menu has five GUI elements: File, View, Export, NXP, and Help.



7.1.1.1 File

Load or save a configuration or exit the application. Load and save are only enabled when OTP tool tab is active.



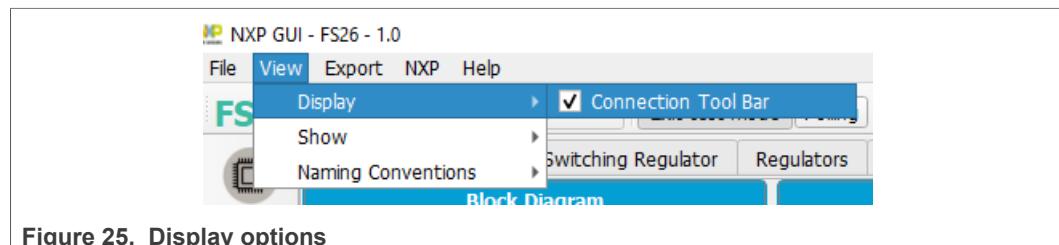
- **Load:** Loads an existing configuration file previously exported from OTP tool to continue to modify it on the OTP tool. This file has a .cfg extension. It is identified as: FS26_ProgIDASILlevel_CONFIG.cfg.
Example: FS26_A0D_CONFIG.cfg.
- **Save:** Saves the current configuration of the OTP tool as a .cfg file.
- **Use default configuration:** Loads default values into the OTP tool.
- **Exit:** Exits NXP GUI application

7.1.1.2 View

This main menu has options related to GUI display.

- Display
- Show
- Naming Conventions

Display: It consists of Connection Tool Bar (enabled by default) option. To show or hide, go to **View** → **Display**, and then select **Connection Tool Bar**.



Show: This option can be used to access various sections of the GUI.

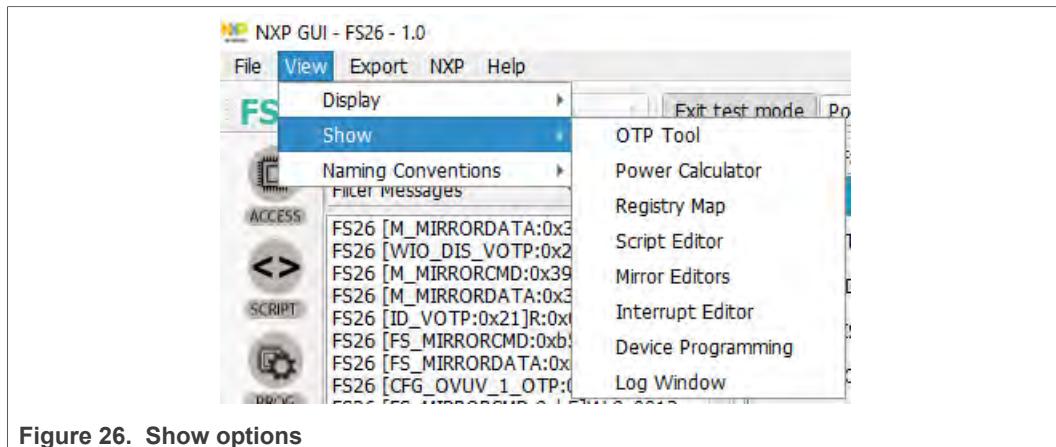


Figure 26. Show options

Naming Conventions: Select Friendly or Register name display for OTP tool. Option enabled only when OTP tool is active.

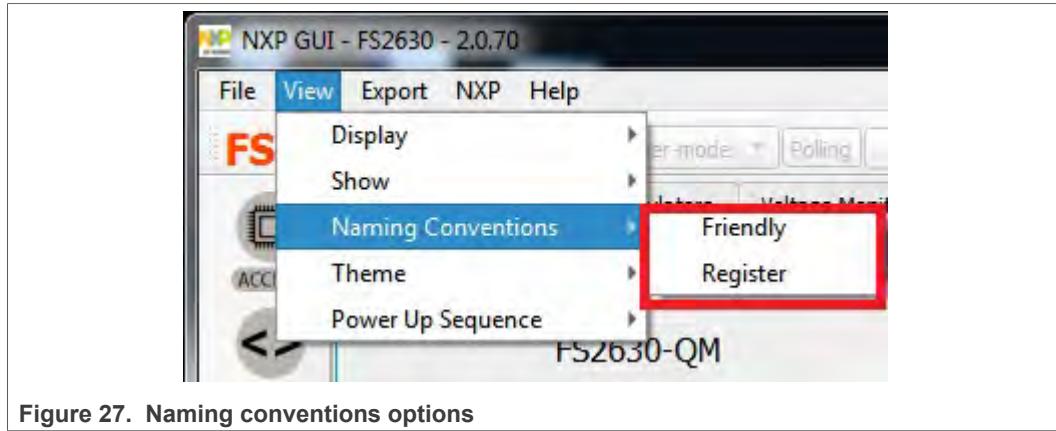


Figure 27. Naming conventions options

Friendly: Go to View → Naming Conventions → Friendly. This mode helps to view the registers names as user-friendly names throughout the OTP tool.

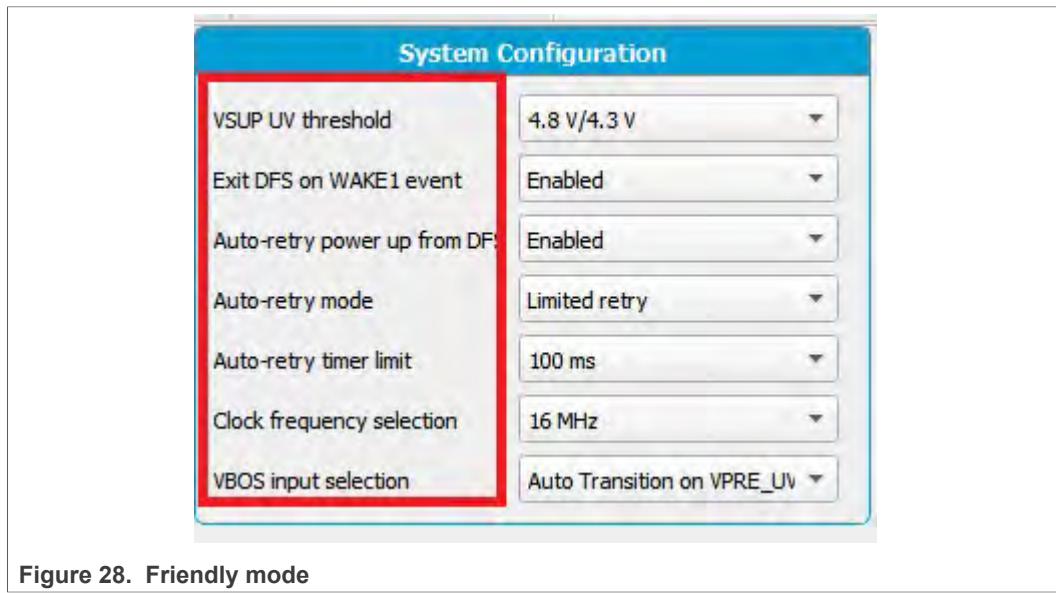


Figure 28. Friendly mode

Register: Go to View → Naming Conventions → Register. This mode helps to view the register names as register's technical names throughout the OTP Tool.

Example: VSUP UV threshold → VSUP_UVTH OTP

7.1.1.3 Export

This option allows user to export the current OTP from the OTP tool into different script formats.

- **OTP:** Exports OTP configuration into OTP script file for programming.
- **TBB:** Exports OTP configuration into a TBB script file for emulation
- **I-HEX:** Exports to Intel Hex script file
- **S-HEX:** Exports to Simple Hex script file

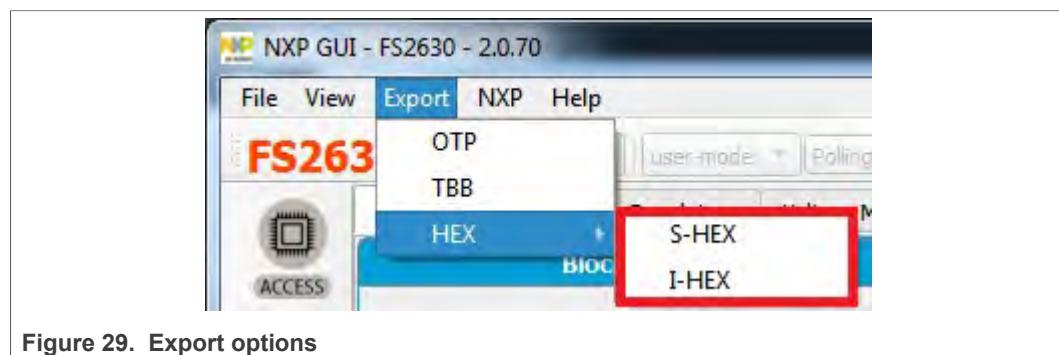


Figure 29. Export options

This option is enabled only in OTP Tool and remains disabled in other sections of the GUI.

7.2 Device manager

The device manager allows start/stop of communication with device as well as enter/exit of the test mode; it also allows quick access to execute useful system scripts.



Figure 30. Device manager

7.2.1 Device connection

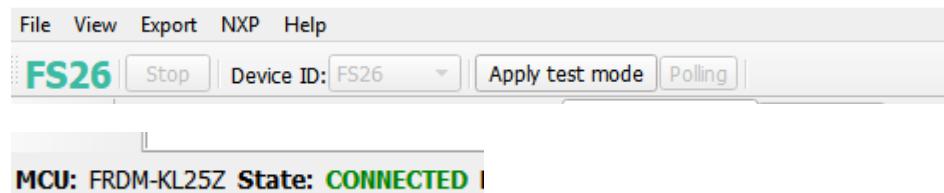
If USB is detected from USB and device status bar, the USB status changes from **NOT DETECTED** to **DISCONNECTED**. Start button is enabled.



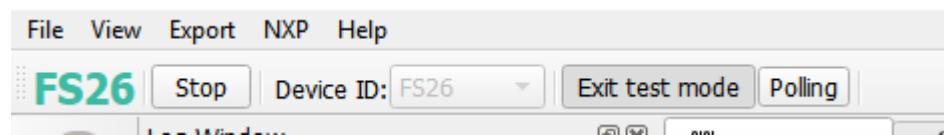
Click **Start** to initiate communication with FS26 device.



When connected successfully, FS26 color changes to green and other buttons are enabled. USB status changes to **CONNECTED**.



Apply test mode to send Main and Fail-safe Test mode entry keys. If test mode is entered correctly, button changes to "Exit test mode".



When test mode is entered, options requiring test mode are enabled, such as Mirrors and device programming.

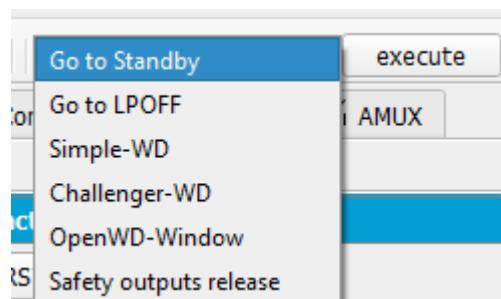
Click **Polling** to do a continuous check of test mode entry.

If the device versioning bits are already programmed with an existing part number, the NXP GUI decodes and displays the assigned Device ID. The following example displays FS2633D.



7.2.2 Script shortcuts

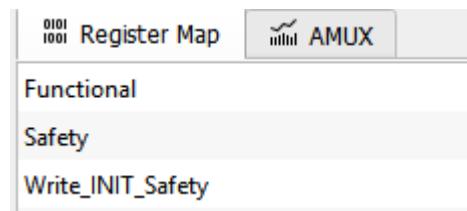
To find a section with system script shortcuts, select the script and click **execute**. This does not warrant the entry **or acknowledge of the device**. Device must be in INIT FS state in most cases.



7.3 Access

7.3.1 Register map

The register access tab allows read/write to the FS26 Main and Fail-safe register maps and is divided into following sections:



- **Functional:** Main functional SPI registers (diagnostics, configuration, and controls)
- **Safety:** Safety SPI registers (diagnostics and configuration)
- **Write_INIT_Safety:** Safety registers that can be configured during INIT FS state (for example, WD configuration and WD window).

Register Mod	AMUX							
Functional	M_DEVICEID (0x00)	Read	0x01C0					AMUX
Safety								
Write_INIT_Safety	FULL_LAYER_REV[2]	FULL_LAYER_REV[1]	FULL_LAYER_REV[0]	METAL_LAYER_REV[2]	METAL_LAYER_REV[1]	METAL_LAYER_REV[0]	FAM_ID[3]	FAM_ID[2]
	FAM_ID[1]	FAM_ID[0]	DEV_ID[5]	DEV_ID[4]	DEV_ID[3]	DEV_ID[2]	DEV_ID[1]	DEV_ID[0]
	M_PROGID (0x02)	Read	0x0000					
	PROG_IDH[7]	PROG_IDH[6]	PROG_IDH[5]	PROG_IDH[4]	PROG_IDH[3]	PROG_IDH[2]	PROG_IDH[1]	PROG_IDH[0]
	PROG_IDL[7]	PROG_IDL[6]	PROG_IDL[5]	PROG_IDL[4]	PROG_IDL[3]	PROG_IDL[2]	PROG_IDL[1]	PROG_IDL[0]
	M_STATUS (0x04)	Read	0x0000					
	TWARN_S	RESERVED	RESERVED	VBSTFB_UV_S	HW2_S	HW1_S	IO2_S	IO1_S
	VREF_S	VBST_S	VPRE_S	TRK2_S	TRK1_S	CORE_S	LD02_S	LD01_S
	M_TS0_FLG (0x06)	Read	0x0000	Write	0x0000			
	TWARN_I	RESERVED	RESERVED	RESERVED	RESERVED	RESERVED	RESERVED	RESERVED
	RESERVED	IO1TS0_I	VPRETS0_I	TRK2TS0_I	TRK1TS0_I	CORETS0_I	LD02TS0_I	LD01TS0_I
	M_TS0_MSK (0x08)	Read	0x0000	Write	0x0000			
	TWARN_M	RESERVED	RESERVED	RESERVED	RESERVED	RESERVED	RESERVED	RESERVED
	RESERVED	IO1TS0_M	VPRETS0_M	TRK2TS0_M	TRK1TS0_M	CORETS0_M	LD02TS0_M	LD01TS0_M
	M_REG_FLG (0x0A)	Read	0x0000	Write	0x0000			
	RESERVED	RESERVED	RESERVED	RESERVED	RESERVED	RESERVED	RESERVED	VBSTOV_I

There are three types of registers: read only (only read button), write only (only write button) or read/write (read and write buttons).

7.3.1.1 Register read only

To read the values of a register, click **READ**; the value is read from the device and displayed on label near **READ** button, and is displayed on the log window.

<input type="checkbox"/> M_DEVICEID (0x00)	Read	0x01C0	
FULL_LAYER_REV[2]	FULL_LAYER_REV[1]	FULL_LAYER_REV[0]	METAL_LAYER_REV[2]
FAM_ID[1]	FAM_ID[0]	DEV_ID[5]	DEV_ID[4]

Figure 31. Read only register

To view the values of all the bits from a register after read operation, click **Edit button**. Bits are read with their corresponding values displayed as a pop-up window.

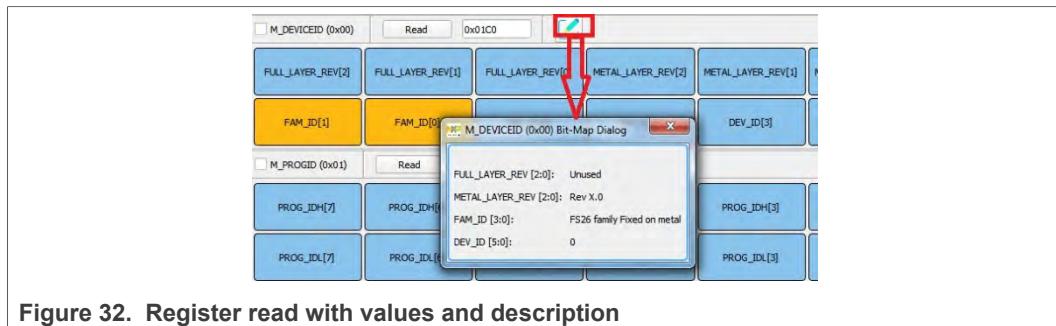


Figure 32. Register read with values and description

7.3.1.2 Register read/write

To read or write the bit values individually, click each bit button; the value is read from the bit or written to the bit based on its properties and displayed on the log window and in the label near **READ** and text box near **WRITE** button correspondingly. The bit button color changes accordingly.

7.3.1.3 Global read/write

The global read/write and reset option is located at the bottom left section of the register tab.

The **SELECT ALL** option selects all the registers on the tab.

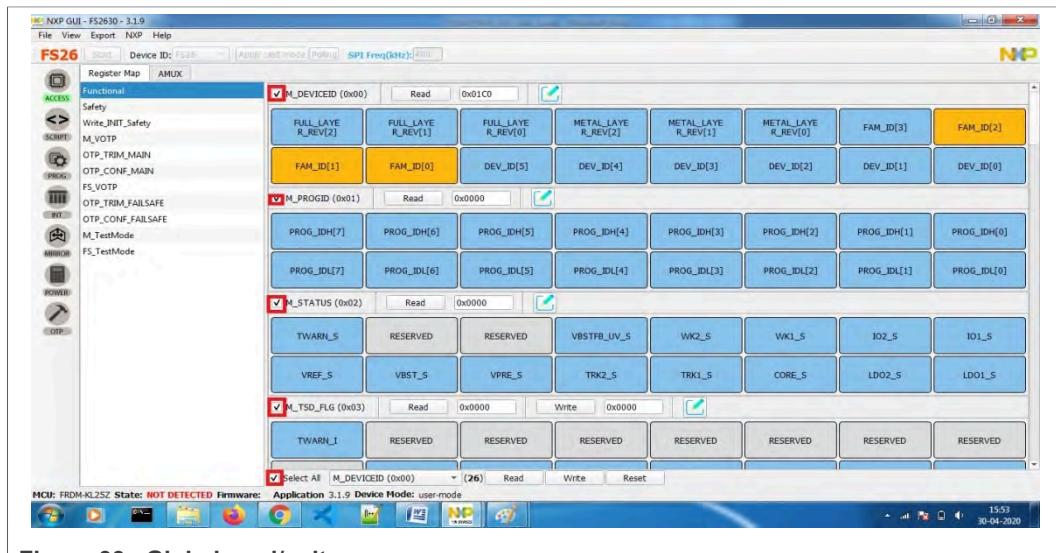
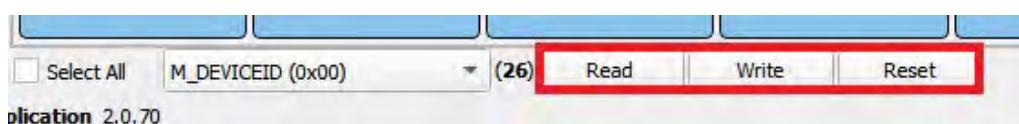


Figure 33. Global read/write

WRITE: Writes data to all selected registers at once

READ: Reads data back from the selected register at once

RESET: Resets all the input textbox to 0x00. Write bits are set to 0 and change register bit buttons to default setting



7.3.2 INIT Safety

Configure reaction of safety outputs for VMON, FCCU, ERMON, and configure Fault Monitor. It is required to be in INIT FS to configure registers. Click **Read All** to get current configuration, then modify it.

Click the combo box controls to select configuration, then click **Write**.

Click **Read** or **Read All** to get configuration; read values appear to the right of controls.

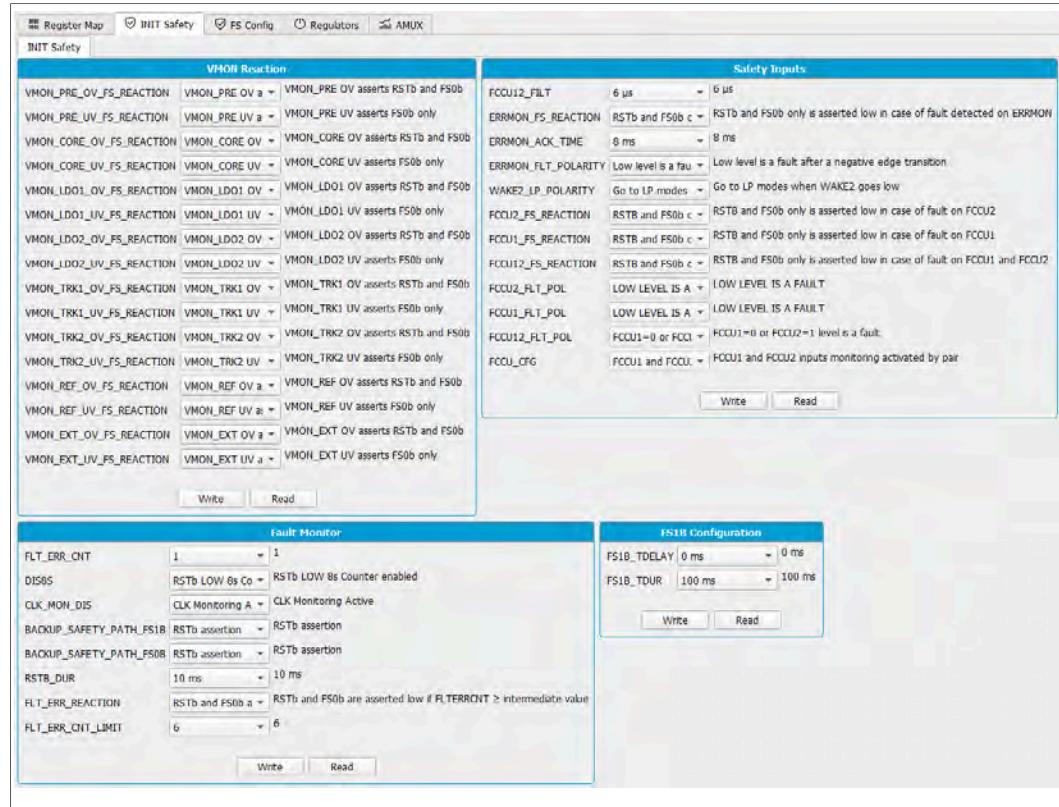


Figure 34. INIT Safety

To get current state, click **FS_STATES** display from USB and Device status bar on the bottom.

7.3.3 FS Config

This tab helps to configure safety features such as Watchdog and fault error counter.

Click **Read All** to get current configuration.

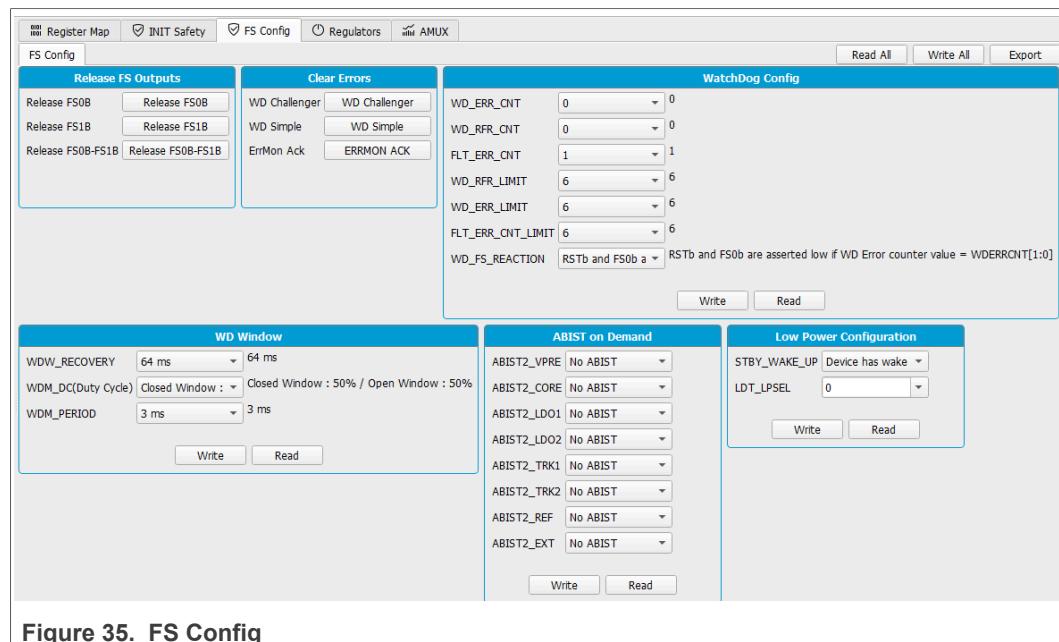


Figure 35. FS Config

7.3.4 Regulators

Enable or disable FS26 regulators. Check enable or disable box, then click **Write** button. These registers do not provide regulator status; it writes '1' to apply the command then restart to 0. Write '0' has no effect. VPRE can be only enabled or disabled in test mode.

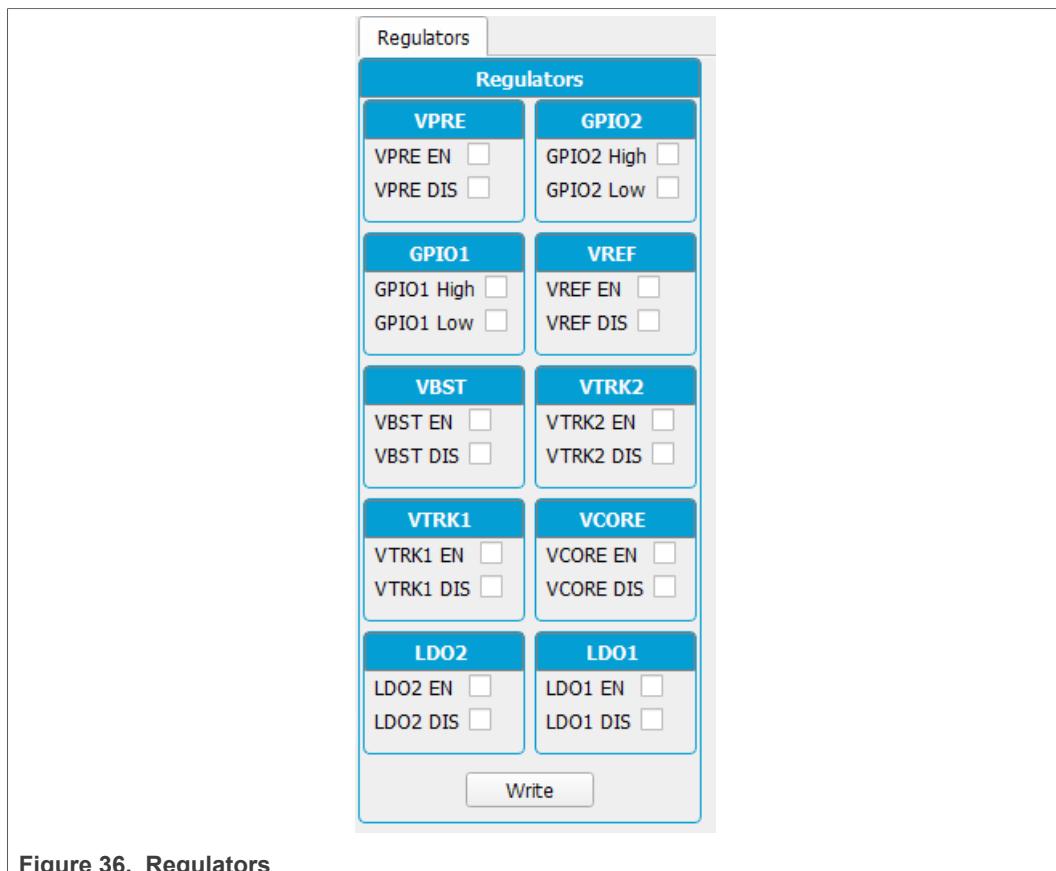


Figure 36. Regulators

7.3.5 AMUX

This tab can be accessed from Toolbar → REG ACCESS or View → Show → Registry Map → AMUX Registers.

This tab allows selection of AMUX pin channel and gets its current value by using KL25Z AMUX ADC pin. The voltage or temperature graph can do a single read or dynamically display various channels.

The displayed values apply to the divider and temperature formulas.

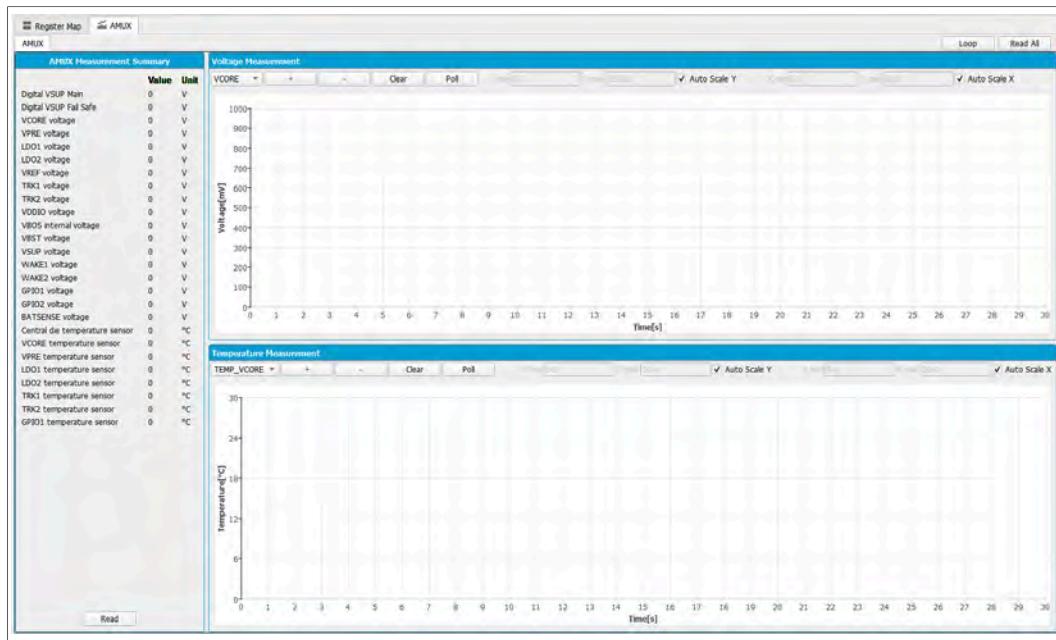


Figure 37. AMUX

To do a single read of all channels click **Read**.

To use the dynamic graph, select the channel then click **+** button to add to the graph and then start polling with **Poll** button.

Click **Poll** again to stop measurements.

7.4 Script editor

The script editor allows you to create or send existing sequences to the device. You can read/write individually to a register, to an I/O, or to an analog pin. You can emulate an OTP configuration as well with this tab.

This tab can be accessed from Toolbar → SCRIPT or View → Show → Script Editor.

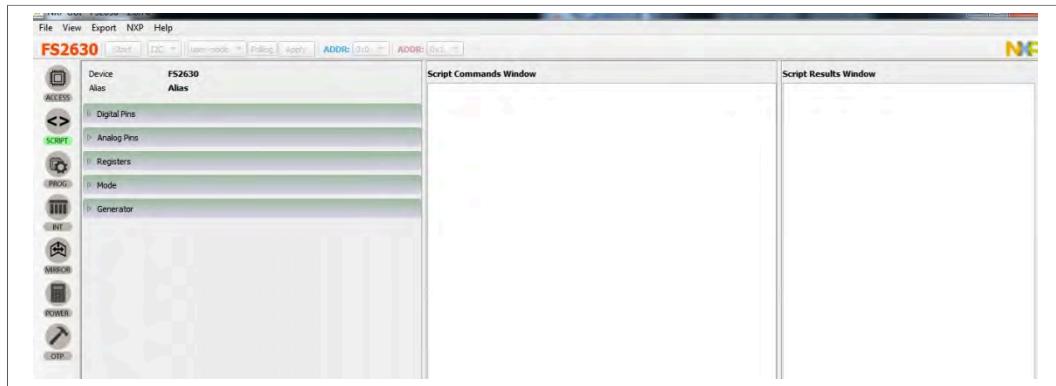


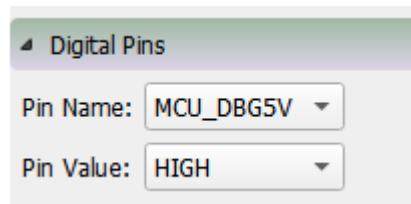
Figure 38. Script editor

The script can be written by selecting and configuring the pins and registers that are available on the script commands section, or by loading a previously exported .txt file.

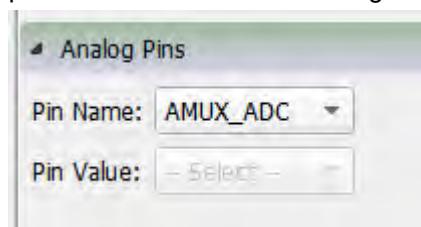


Click one type of command to access more options, until the command to build the sequence is found.

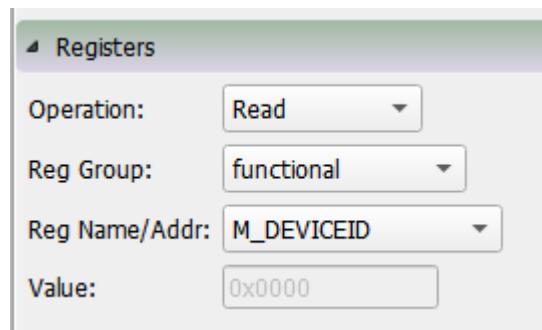
- Digital pins: Select the pin name, then pin value (High or Low). Command is automatically added to the script.



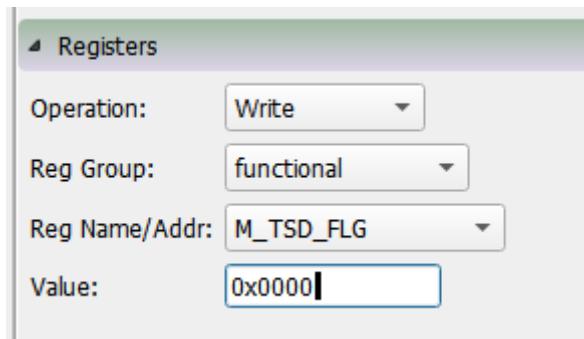
- Analog pins: Select the pin name, and then write the pin value. If the pin is read only, pin value is not enabled and it gets added to script editor automatically.



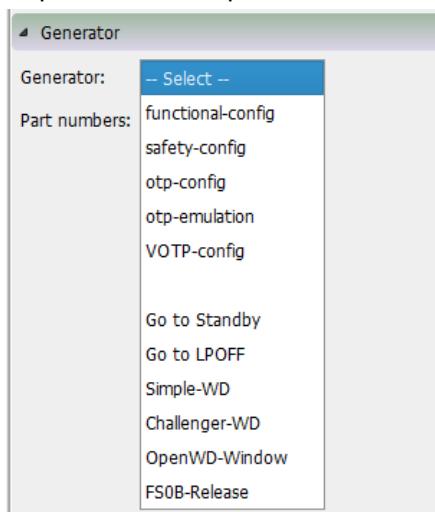
- Registers: Select the Operation (Read/Write).
 - Read: Select the register group then the register name. Register is added to script editor automatically.



- Write: Select the register group then the register name. Write value and click enter key. Value must be written in HEX. Press Enter key to add to the editor.



- Mode: Write command to exit or enter different device modes.
 - Test mode: Send Main and Fail-safe test mode entry keys
 - User mode: Exit test mode if device is in test mode.
- Generator: Select an existing script to add to the script editor. Some options may require to be in a specific mode or state.



The script operations can be found at the bottom of the script editor window. This section is responsible for:

- Execution of script
- Script management: Create, Open, Save, Run
- Logging feature: Load, Save, Clear



Figure 39. Script editor options

Run: Runs the script once

Loop: Runs the script continuously in loop

Save: Saves the script that is present in the script command window in a text file

Open: Opens a saved script from the desired location

ATE: Saves the script in ATE format

Clear: Clears the script command window

Script Editor Help Window: This section describes the commands available in Script editor and their formats. This option can be accessed from Menu → SCRIPT → Help or View → Show → Script Editor → Help.

7.5 OTP Mirror

To enable this option, test mode must be applied. This tab is divided in Main and Fail-safe OTP registers.

Each bit group box can be read or written, or the whole page can be read. OTP configuration can be imported or exported from this tab.

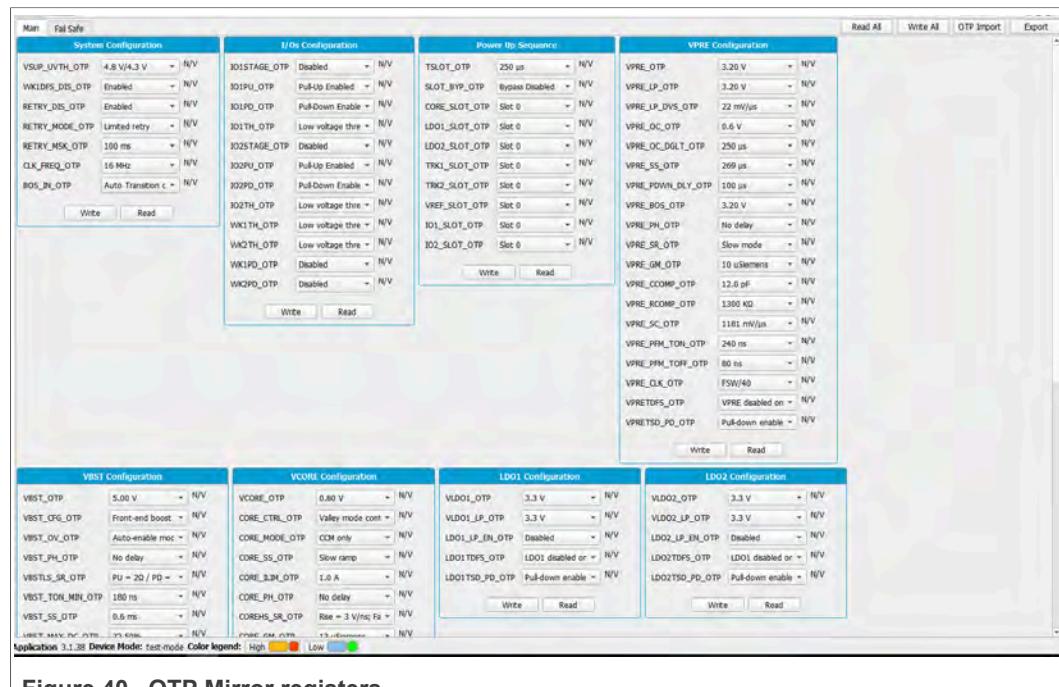


Figure 40. OTP Mirror registers

7.5.1 Read/write operation

To read a bit group, click **Read** from a box. Read values are displayed to the right of each register.

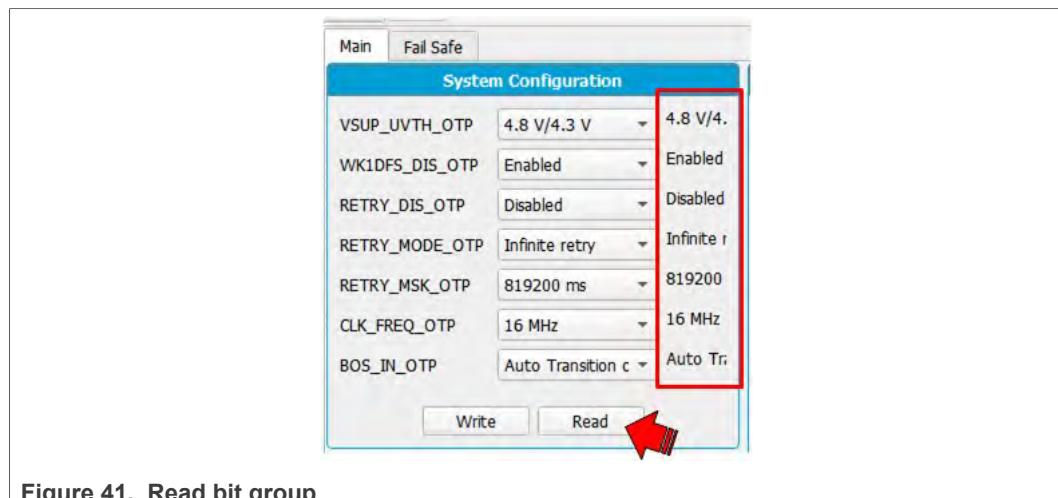


Figure 41. Read bit group

To write to a bit group, modify the controls of each register, then click **Write**.

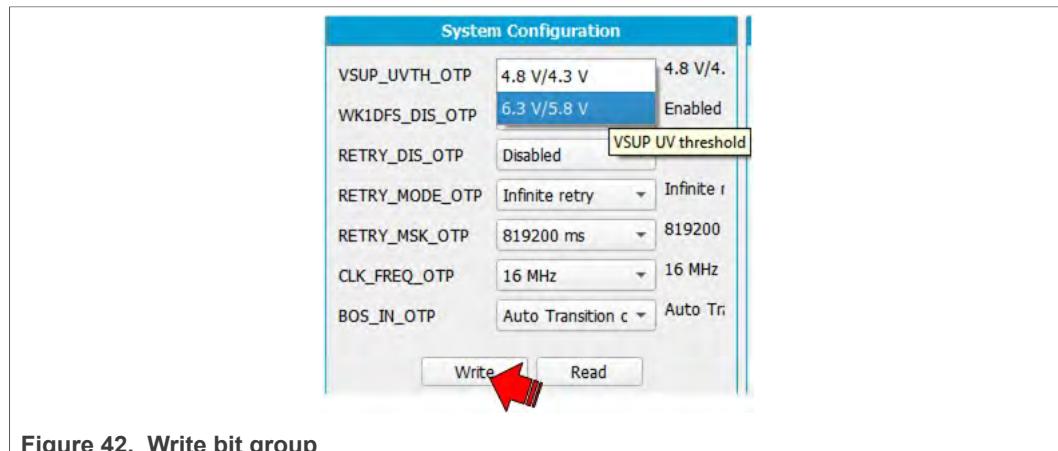


Figure 42. Write bit group

7.5.2 Read/write all and write all operation

Read All reads the bits of each block from all mirror registers.

Read values appear at the right of each register as well on the window log.

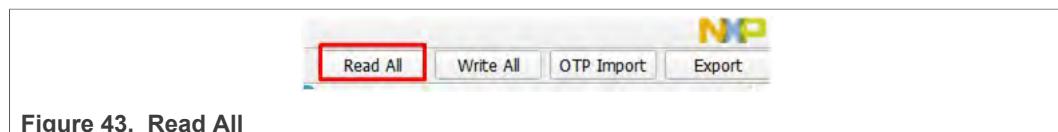


Figure 43. Read All

To write all OTP bit groups configuration, click **Write All**.

7.5.3 Mirror registers export option

This operation generates a configuration file and this file is saved as a text file in local device which can be imported later into this tab. [Figure 44](#) shows the generated .txt configuration file.

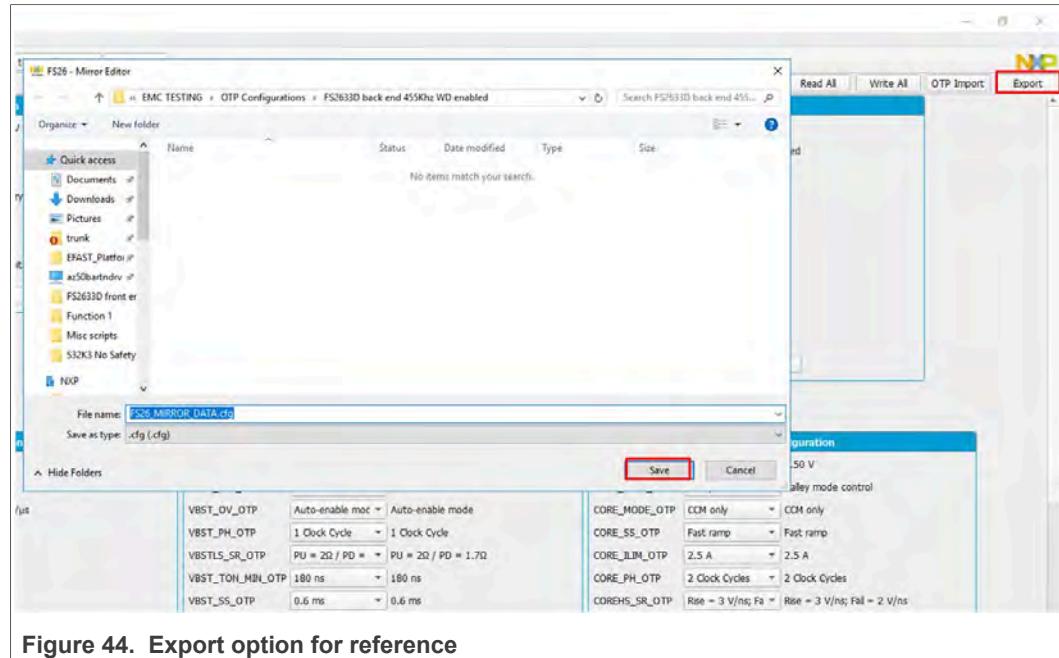


Figure 44. Export option for reference

7.5.4 OTP import to mirror registers

This option is used to import the configuration file previously saved. Click **OTP Import** and select the the.txt configuration file previously saved from this tab.

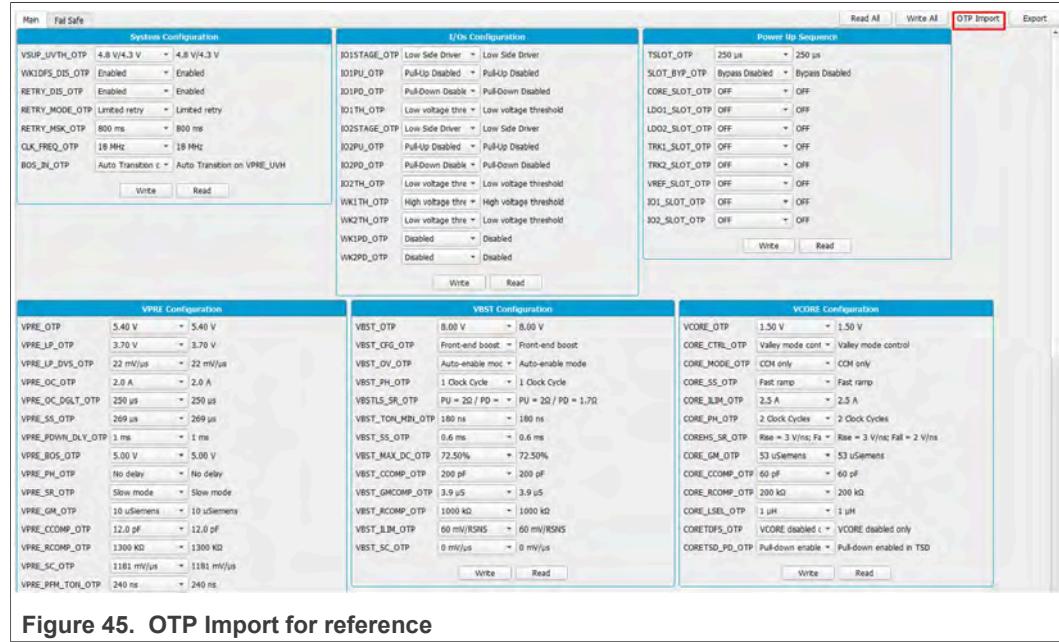


Figure 45. OTP Import for reference

7.6 INT

This option allows access to monitor the regulators and safety events. To access the Interrupt Editor window, click Menu → INT or View → Show → Interrupt Editor.

It is separated in two tabs: Interrupt Configuration and Safety Diagnostic.

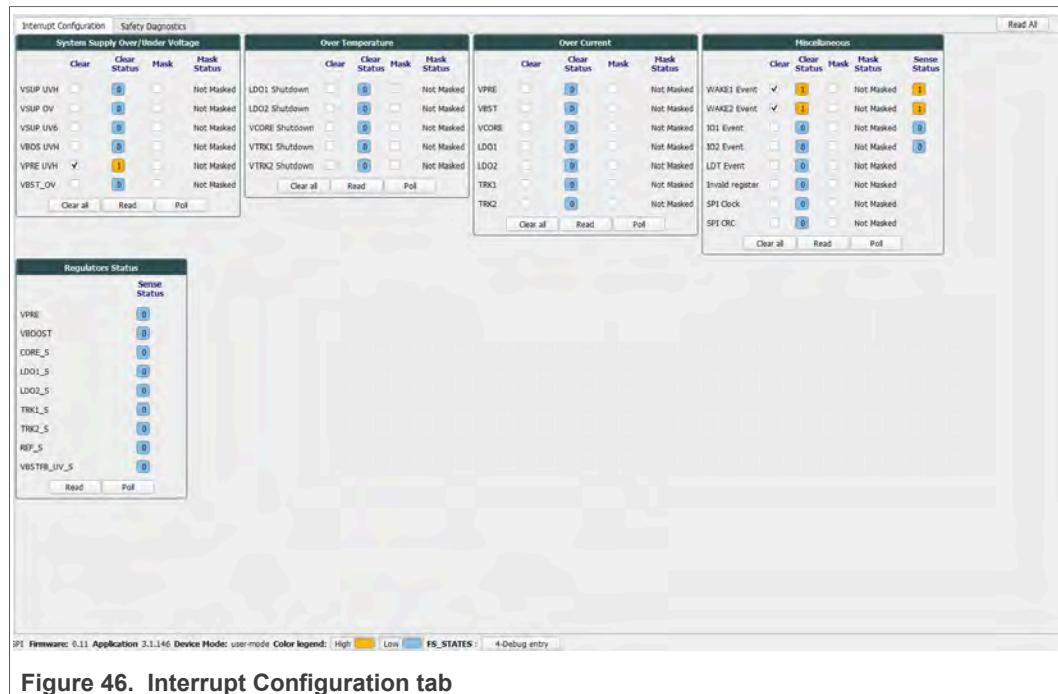


Figure 46. Interrupt Configuration tab

The below legend and functions apply to both tabs:

- **Blue** means Low or not activated
- **Yellow** means High or activated.
- To **clear** flags, click each check box from clear column or click **Clear All**.
- To **mask** the interruption, check the box of each interruption from mask column.
- Click **Read** on each box to read the current status or **Read all** to update the whole tab.
- Use **Poll** button to read each box periodically.

Sense status can be read only.

7.6.1 Interrupt Configuration

This tab allows the user to monitor the regulators, Wake inputs, I/O and communication events or status. It allows read, write and poll over/under voltage, over temperature and over current of device. You can read, clear or mask an interruption.

If an event occurs flag changes to red. When regulators are red or '1' they are turned ON.



Figure 47. Interrupt Configuration

7.6.2 Safety Diagnostics

Safety Diagnostics tab allows the monitoring of safety events such as VMON status, bad WD, SPI communication errors, FCCU pins, safety outputs, ABIST1 and ABIST2 status.



Figure 48. Safety diagnostics tab

ABIST1_PASS Yellow means that it is done and PASS, since we can read '1' from its register. 0 or blue after execution means fail.

7.7 Device programming

This section is used to burn permanently an OTP configuration on the OTP fuses. To enable this window device must be in test mode.

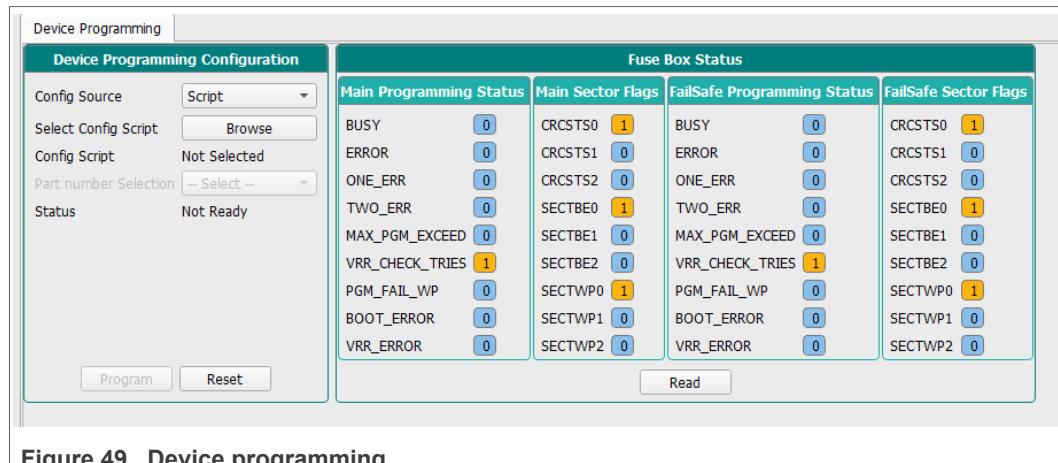


Figure 49. Device programming

To program an OTP configuration Vdebug pin must be higher than VDBG65TH. To apply this voltage, turn on SW7 (Apply 8.0 V to Vdebug).

Click on Browse to select an OTP script file, then click on program button to run the script. If Vdebug not set to 8.0 V, a pop-up appears asking to turn on SW7, or it turns On automatically if jumper J13 is on Automatic mode J13 3-2.

If the required conditions are met (sectors available), the programming starts. Otherwise the execution is cancelled. To verify sectors are available, click **Read** from Fuse Box Status.

OTP is programmed into SECTBE2 of Main and Fail-safe. SECTBE1 and SECTBE0 are reserved for NXP users only.

Blue or '0': Available

Yellow or '1': Not available

When programming is complete, a pop-up appears to request to turn Off SW7 and SW6 (set Vdebug to 0 V).

If the device was programmed correctly the power-up sequence starts. Fuse box status can be read to verify if sectors are burned. In some conditions a power up could be required.

7.8 OTP tool

This option allows user to configure OTP registers, save configurations, and generate scripts in different file formats which can be burnt (OTP script) or emulated (TBB script) into the FS26 SBC. See [Section 7.1.1.3 "Export"](#).

To access the FS26 OTP tool, launch NXP GUI application and navigate to **OTP**. To access OTP Tool from menu, go to **View** → **Show/Hide** → **OTP Tool**.

It is possible to save a configuration to visualize or modify it later. Click **Save Config** to export or go to **File** and then select **Save**. To import, click **Import** or go to **File** and then select **Load**.

7.8.1 OTP tool application

All blocks in the OTP tool use default values configured on launch. It consists of the following configuration sections:

- System Configuration
- Switching Regulators
- Regulators
- Voltage Monitoring
- System Safety Configuration

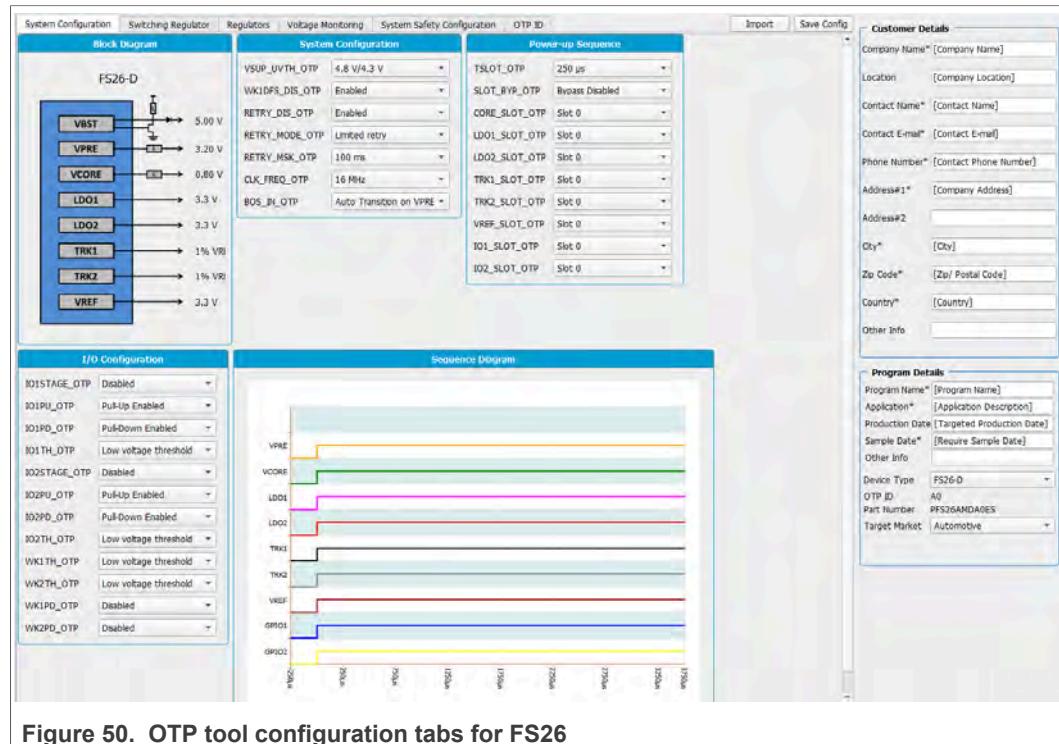


Figure 50. OTP tool configuration tabs for FS26

7.8.2 OTP configuration sections

7.8.2.1 System Configuration

This block consists of the parameter (bits) settings that are related to the system configuration registers of FS26. It displays block diagram with the selected regulators output values from Regulators section. It contains the power up sequence configuration which is displayed in the sequence diagram. You can configure the I/O and wake inputs as well.

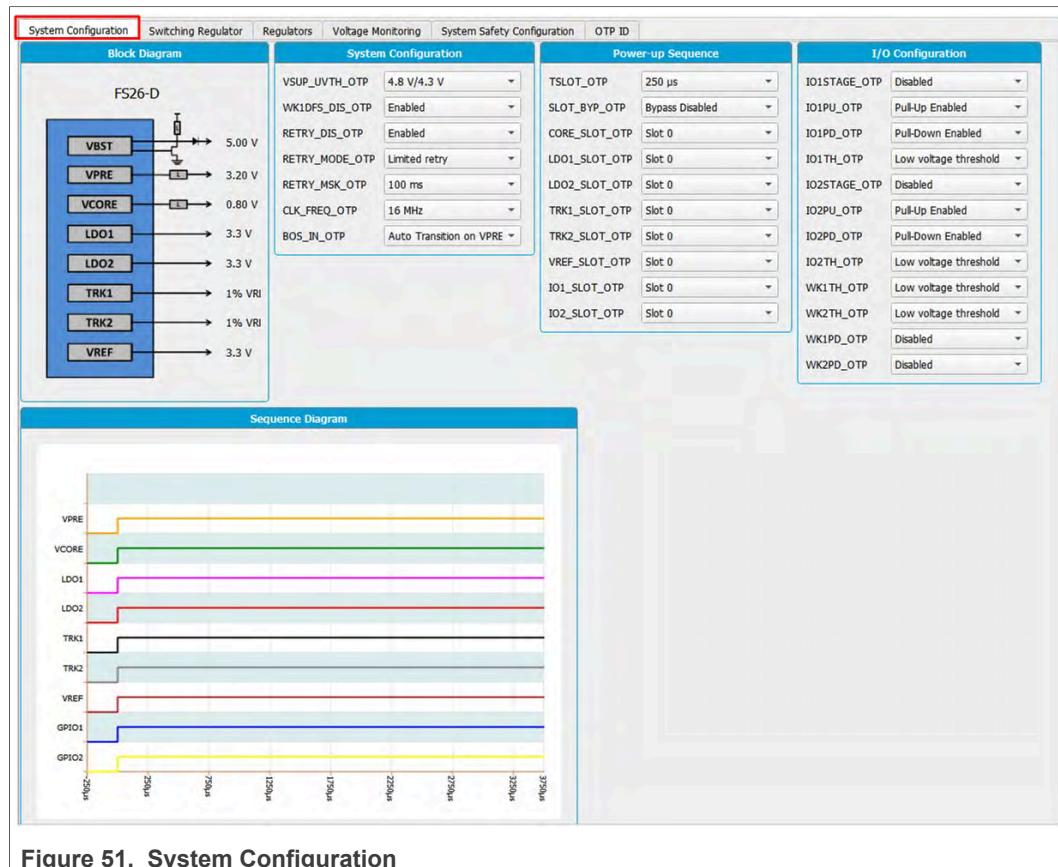


Figure 51. System Configuration

7.8.2.2 Regulators

The FS26 regulators are separated in two tabs: Switching regulators and Regulators (LDOs).



Figure 52. Regulators Tabs

The switching regulators can configure VPRE, VBST and VCORE output values and its internal parameters. Select the Power topology by configuring the VBST_CFG_OTP bit group.

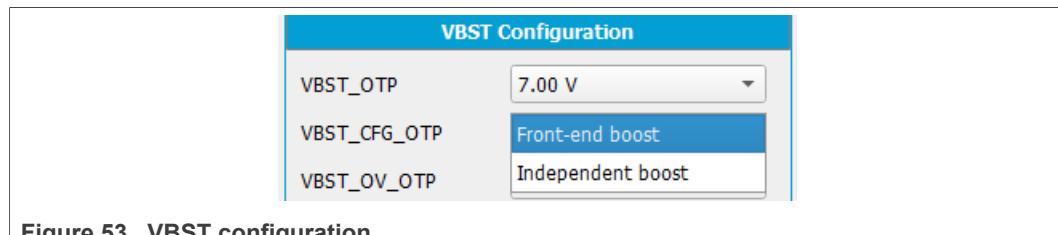


Figure 53. VBST configuration

The Regulators tab consists of VLDO1, VLDO2, VTRK1, VTRK2, VREF output values and its TSD behavior.

7.8.2.3 System Safety Configuration

This tab allows user to configure ABIST1 for each regulator, configure system reaction in case of Fault or enable and disable Watchdog timer.

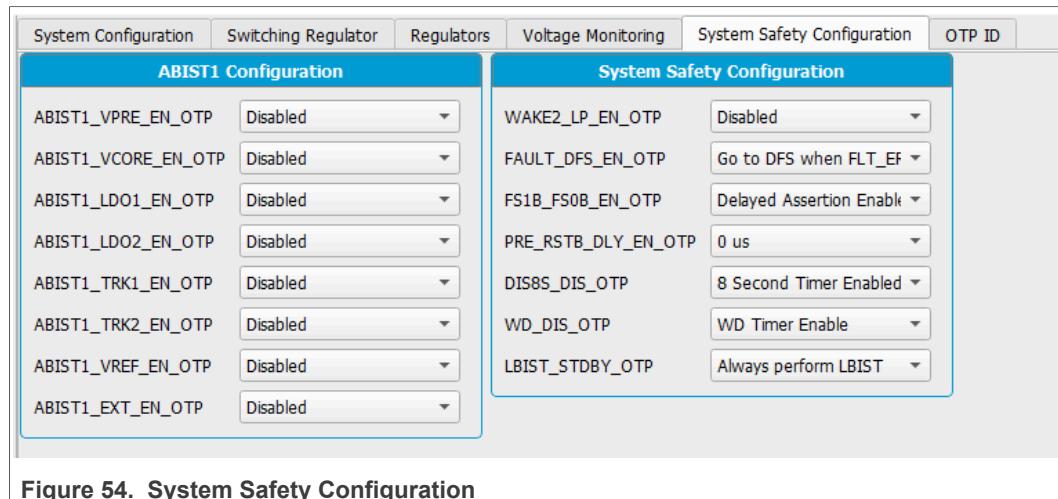


Figure 54. System Safety Configuration

7.8.2.4 Voltage Monitoring

This tab allows user to configure FS26 voltage monitoring and consists of the following:

- VMONPRE configuration
- VMONLDO1 configuration
- VMONCORE configuration
- VMONLDO2 configuration
- VMONEXT configuration
- VMONREF configuration

Make sure that each VMON is assigned with the same voltage output value configured on Regulators tab, then select its fault OV/UV threshold and filtering time.

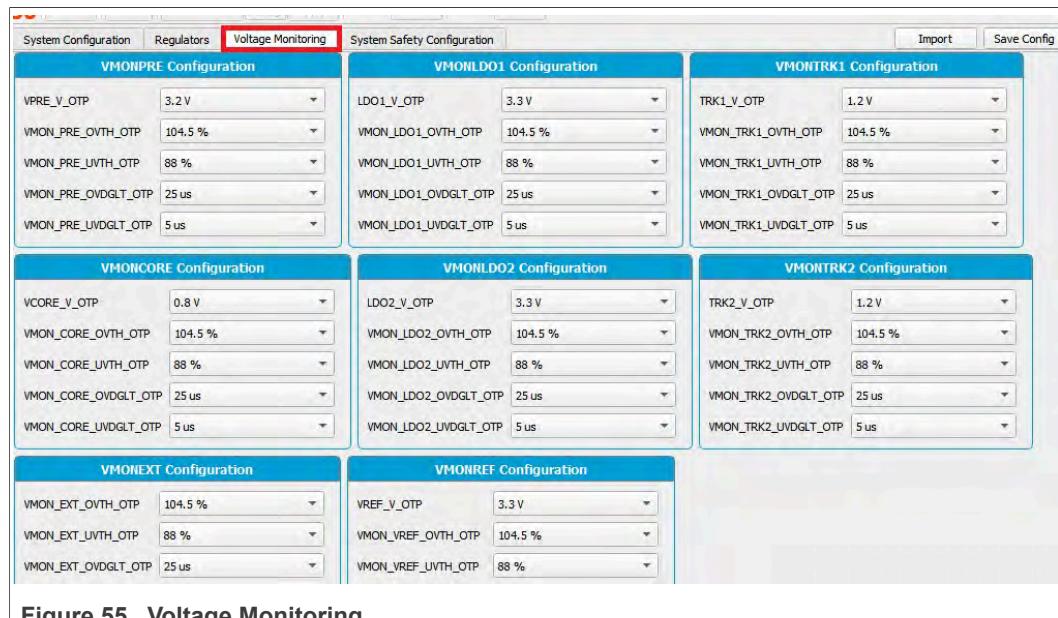


Figure 55. Voltage Monitoring

7.8.2.5 OTP ID

Displays OTP ID. Only NXP users can create a new OTP ID.

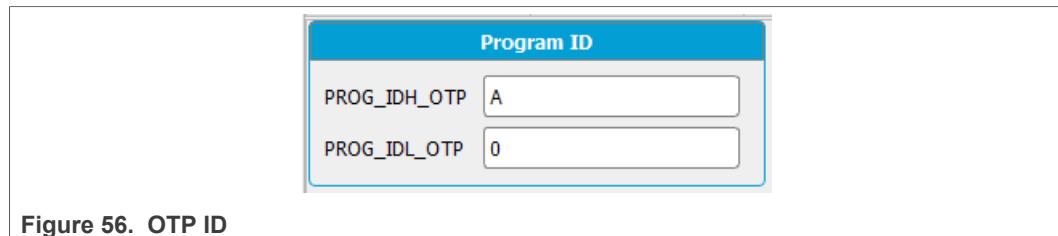


Figure 56. OTP ID

7.9 I/O pins

This section can control some I/Os connected to the KL25Z plugged-in Freedom. It can read the device safety outputs externally or control different voltage sources in order to apply sequences to apply debug mode without moving any switches.

The input pins are the pins that can be read from the MCU; they are input pins from MCU point of view. This section contains the safety outputs FS0B, FS1B and RSTB. It can be read once with Read button, or you can select at which frequency you want to the read the pins. Select the duration then start polling with **Poll** button.

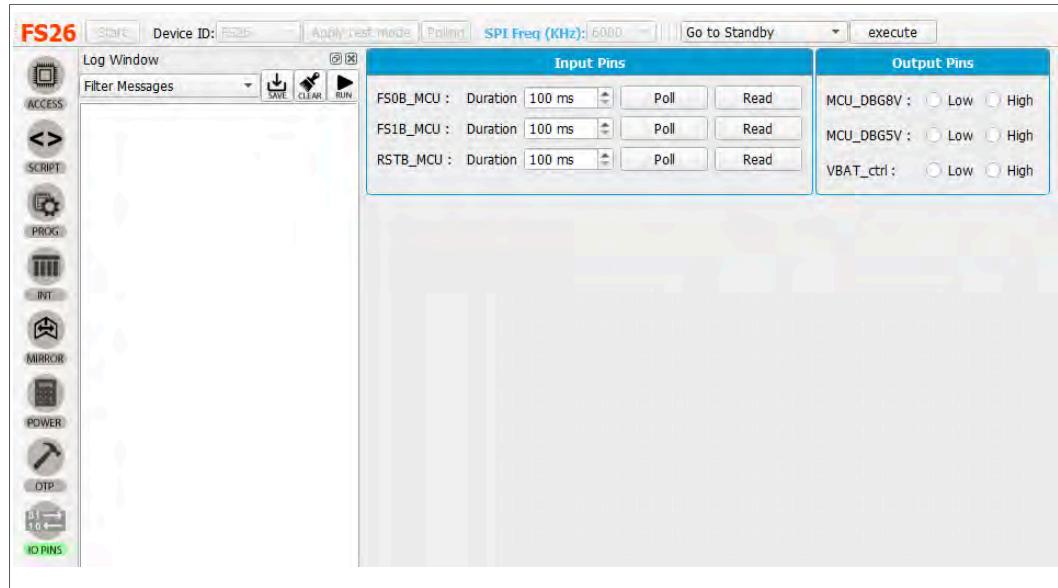


Figure 57. I/O pins

The output pins are thresholds that can be controlled with MCU. These pins are described in [Section 4.2.10 "VDEBUG pin voltage control"](#)

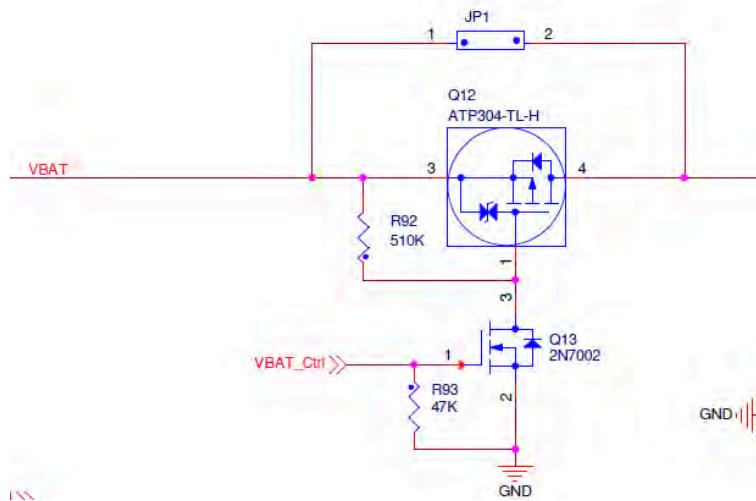
VBAT_Ctrl: Open or close VBAT power supply

MCU_DBG5V: 5 V on VDebug pin

MCU_DBG8V: 8 V on VDebug pin

They can be used instead of the Manual switches SW6 and SW7. In order to use MCU_DBG5V and MCU_DBG8V for debug pin control, J13 must be on "Auto mode" J13 position 3-2. Select high or low to control the pins, default is low.

To use VBAT_Ctrl the red jumper JP1 next to the VBAT switch must be OFF. Once JP1 is removed, use VBAT_Ctrl instead of SW1 to turn the power supply on or off.



These pins are also accessible from script editor and be used to create script sequences.

8 Using FS26 NXP GUI

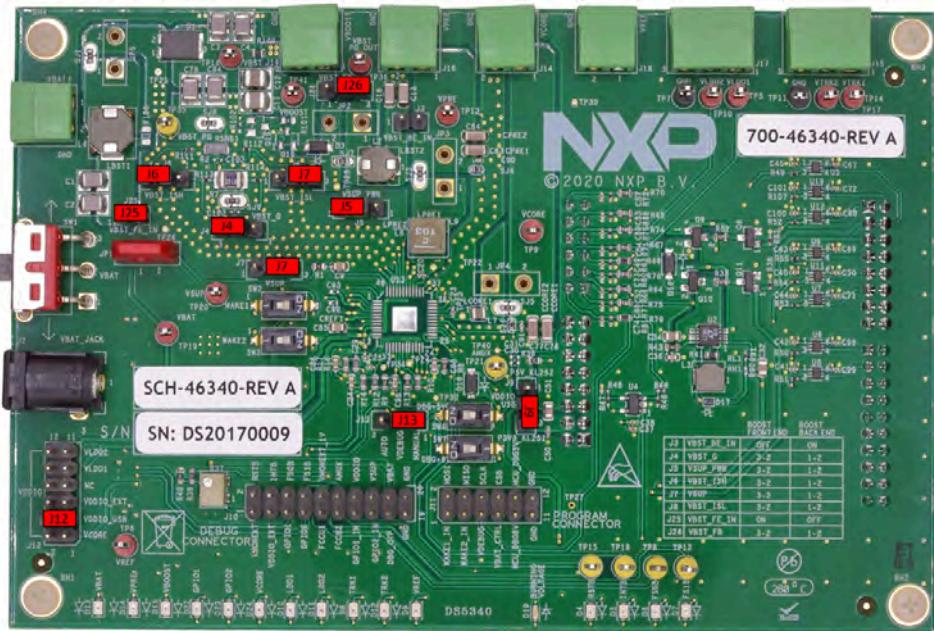
Once the NXP GUI ([Section 5.2 "Installing GUI software package"](#)) is installed, follow these instructions for a quick power up, debug, programming, or entering the different operating modes of the FS26 SBC.

8.1 Power up

If the FS26 device contains an OTP configuration, connect a power supply to the VBAT Phoenix connector or the VBAT jack connector. See [Section 4.2.2 "VBAT connectors"](#).

It is recommended to set the power supply to an initial value of 12 V and limit current to 1.0 A.

Make sure the board has the correct jumper configuration. Every kit is delivered with a default configuration shown in the following figure. This configuration is enabled for a boost in front-end topology.



Verify that the KL25Z Freedom is plugged in, as well as the USB cable on KL25Z USB connector side. It is important that the USB cable is connected since in addition to enabling the communication with the NXP GUI, it provides voltages and references to some circuits on board as well as generates the VDDIO reference for the IC.



Since all the previous statements are valid or considered, switch SW1 can be used to power on the board.

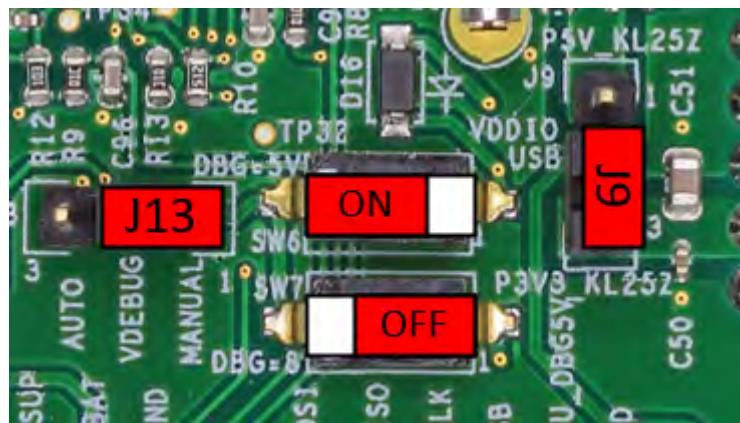
If the OTP configuration has many safety features enabled, the device may restart or power Off after a few seconds. To prevent this, enter debug mode to waive some of those features.

8.2 Debug mode entry

To modify any parameters or to communicate with the IC, enter debug mode. Refer to the power and connection statements from [Section 8.1 "Power up"](#).

Once the kit is ready, follow the next steps:

1. Make sure the device is powered Off (SW1 middle position).
2. Turn On SW6 to apply 5.0 V to the VDebug pin. Make sure the jumper of J13 has the right configuration, default is Manual. See [Section 4.2.10 "VDEBUG pin voltage control"](#) for more details.



3. Power on VBAT, and the device enters debug mode, this allows access to the register map, to emulate or to program an OTP configuration on the NXP GUI.
4. To verify debug mode, use the NXP GUI Register map window to Read FS_STATES(0x17) or click on FS_STATES display from USB and device status bar.

FS_STATES : 4-Debug entry

It is possible to start power up sequence and stay in debug mode. In order to start power up sequence, turn SW6 to put VDebug pin to 0 V.

8.3 Test mode entry

To enter test mode, the device must be in Debug mode. Test mode can be accessed by writing the appropriate key sequences.

Access test mode from NXP GUI device manager or write the keys to the script editor.

From Device Manager: Click **Apply test mode** to send the Main and Failsafe test mode entry keys.

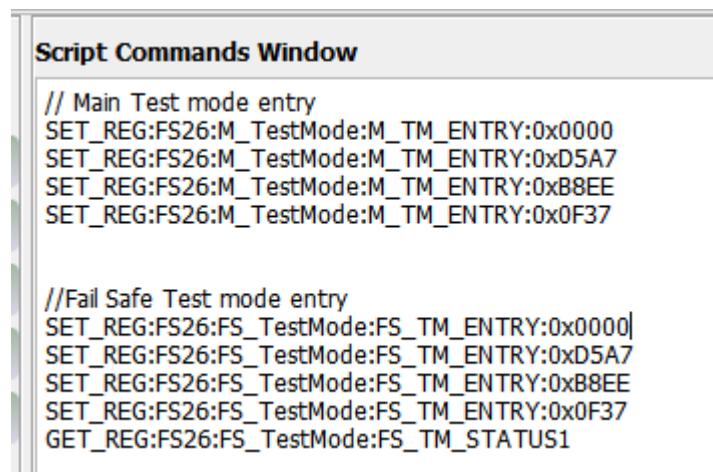


From Script Editor:

Copy and paste the keys in the script editor:

```
// Main Test mode entry
SET_REG:FS26:M_TestMode:M_TM_ENTRY:0x0000
SET_REG:FS26:M_TestMode:M_TM_ENTRY:0xD5A7
```

```
SET_REG:FS26:M_TestMode:M_TM_ENTRY:0xB8EE
SET_REG:FS26:M_TestMode:M_TM_ENTRY:0x0F37
//Fail Safe Test mode entry
SET_REG:FS26:FS_TestMode:FS_TM_ENTRY:0x0000
SET_REG:FS26:FS_TestMode:FS_TM_ENTRY:0xD5A7
SET_REG:FS26:FS_TestMode:FS_TM_ENTRY:0xB8EE
SET_REG:FS26:FS_TestMode:FS_TM_ENTRY:0x0F37
GET_REG:FS26:FS_TestMode:FS_TM_STATUS1
```



Click Run Script.



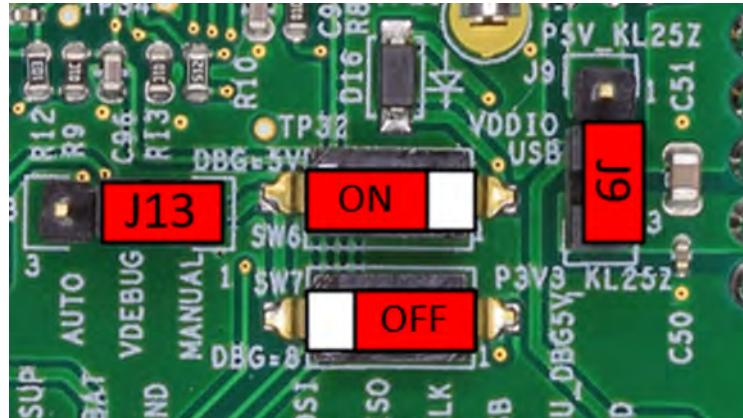
8.4 Emulate an OTP configuration

Before starting, make sure that the power conditions from [Section 8.1 "Power up"](#) are valid.

If not in debug mode:

1. Ensure the device is powered Off (SW1 middle position).

2. Turn On the SW6 to apply ~4.5 V to the VDebug pin. Make sure that the jumper of J13 has the right configuration; default is Manual. See [Section 4.2.2 "VBAT connectors"](#) for more details.



3. Power On VBAT(SW1), and the device enters debug mode.

If already in debug entry:

1. Open the NXP GUI, connect the device, and open the script editor.
2. Open the provided or created OTP configuration script (TBB) to load into the mirror registers.



3. Click Run Script.

A TBB script contains usually Test mode entry keys; if it does not have it, see [Section 8.3 "Test mode entry"](#) to enter test mode.

After running the script, read the mirror registers to verify the loaded OTP configuration in the OTP Mirrors tab. Turn the VDebug (SW6) switch to 0 V to start the power up sequence.

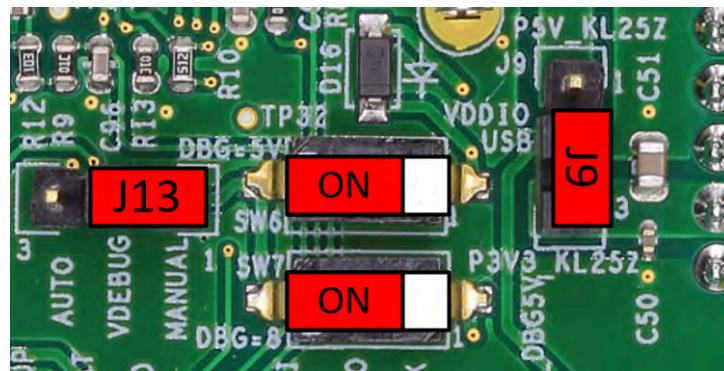
8.5 Program an OTP configuration

This section is intended to burn an OTP configuration permanently into the fuses. The device sectors can be programmed only one time. Make sure that sectors are available.

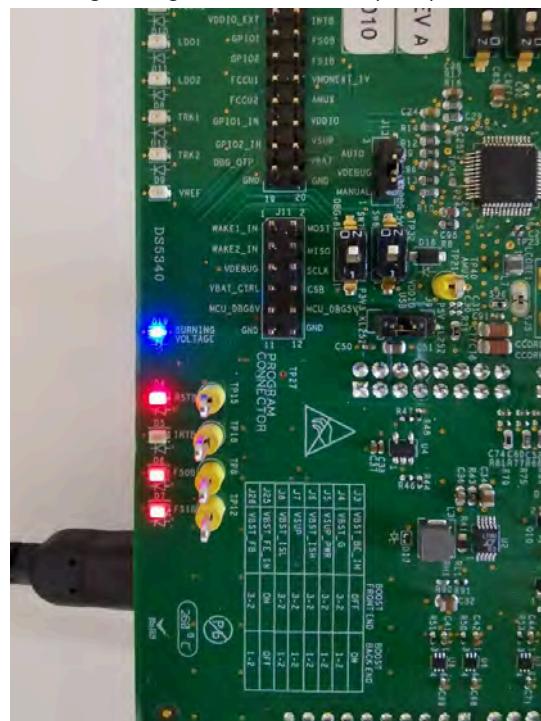
You can program an OTP configuration from Device Programming tab or from the script editor. See [Section 7.7 "Device programming"](#).

1. If not in debug mode, see [Section 8.2 "Debug mode entry"](#).

2. Turn SW7 On to apply ~8 V to the VDebug pin in order to reach the OTP burning threshold VDBG65TH. A blue LED (D19) indicates if this voltage is turned on



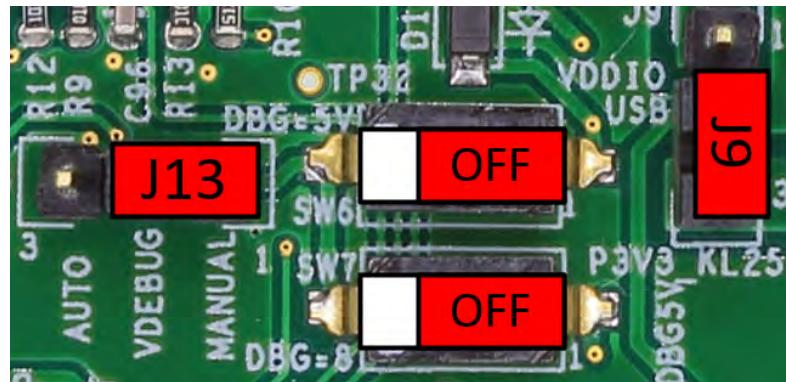
Burning voltage LED indicator (D19):



3. Open the NXP GUI, connect the device, and go to the script editor.
4. Open the provided or created OTP configuration script to load on the mirror registers. Then click **Run** to run the script.



- Once the script has been sent, turn Off SW7, then SW6.



- Device should power up with the burned OTP configuration or perform a POR on VBAT to verify the fused OTP configuration.

8.6 Go to INIT FS

From power up:

- Put Debug pin to 5.0 V (SW6 On) to access debug entry.
- Device powers up (SW1).
- If the device does not have an OTP configuration emulate or program an OTP configuration. See [Section 8.4 "Emulate an OTP configuration"](#) for emulation or [Section 8.5 "Program an OTP configuration"](#) for programming.
- Turn Off SW6 to continue the state machine and access INIT FS. You can verify current state from USB and device status bar, then click display to refresh.

FS_STATES : 9-INIT_FS

8.7 Go to INIT FS in debug mode

From power up:

- Put Debug pin to 5.0 V (SW6 On) to access debug entry.
- Device power up (SW1)
- If the device does not have an OTP configuration emulate or program an OTP configuration. See [Section 8.4 "Emulate an OTP configuration"](#) for emulation or [Section 8.5 "Program an OTP configuration"](#) for programming.
- Turn Off SW6 to continue the state machine and access INIT FS. Verify current state from USB and device status bar, and click display to refresh.

FS_STATES : 9-INIT_FS

8.8 Go to Normal mode

To enter Normal mode from GUI, you must be in debug mode and in INIT FS state. If simple Watchdog, use a script to release safety outputs FS0B and FS1B. If Watchdog challenger, sequence must be sent manually.

- Once in INIT FS, Verify ABIST1 passes from Safety diagnostics tab.
- Configure or verify Watchdog type from Mirrors tab.

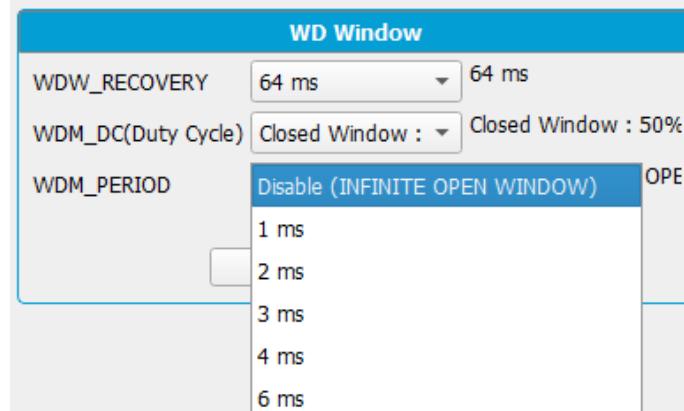
3. Use a script to release safety outputs; use script A for watchdog simple or script B for watchdog challenger. Script to release safety outputs is available in device manager scripts section, rr from script editor → Generator → Safety outputs release script and run.

- a. Sequence to enter normal mode with a Watchdog simple
//INIT FS and simple WD enabled required
//Open WD window
SET_REG:FS26:Safety:FS_WDW_DURATION:0x008B
SET_REG:FS26:Safety:FS_NOT_WDW_DURATION:0xF144
//Send 1 good wd refresh to close INIT window
SET_REG:FS26:Safety:FS_WD_ANSWER:0x5AB2
//clean fault error counter
SET_REG:FS26:Safety:FS_WD_ANSWER:0x5AB2
SET_REG:FS26:Safety:FS_WD_ANSWER:0x5AB2
SET_REG:FS26:Safety:FS_WD_ANSWER:0x5AB2
SET_REG:FS26:Safety:FS_WD_ANSWER:0x5AB2
SET_REG:FS26:Safety:FS_WD_ANSWER:0x5AB2
SET_REG:FS26:Safety:FS_WD_ANSWER:0x5AB2
//Exit dbg mode
SET_REG:FS26:Safety:FS_STATES:0x4000
//release FS0B and FS1B
SET_REG:FS26:Safety:FS_RELEASE_FS0B_FS1B:0xB2A5
 - b. Sequence to enter normal mode with a Watchdog Challenger
//INIT FS and WD Challenger required
//Open WD window
SET_REG:FS26:Safety:FS_WDW_DURATION:0x008B
SET_REG:FS26:Safety:FS_NOT_WDW_DURATION:0xF144
//Send 1 ZD refresh to close INIT window
SET_REG:FS26:Safety:FS_WD_ANSWER:0xa54d
//clean fault error counter
SET_REG:FS26:Safety:FS_WD_ANSWER:0x4a9a
SET_REG:FS26:Safety:FS_WD_ANSWER:0x9535
SET_REG:FS26:Safety:FS_WD_ANSWER:0x2a6a
SET_REG:FS26:Safety:FS_WD_ANSWER:0x54d4
SET_REG:FS26:Safety:FS_WD_ANSWER:0xa9a9
SET_REG:FS26:Safety:FS_WD_ANSWER:0x5353
//Exit dbg mode
SET_REG:FS26:Safety:FS_STATES:0x4000
//release FS0B and FS1B
SET_REG:FS26:Safety:FS_RELEASE_FS0B_FS1B:0xA565

Release safety outputs without script

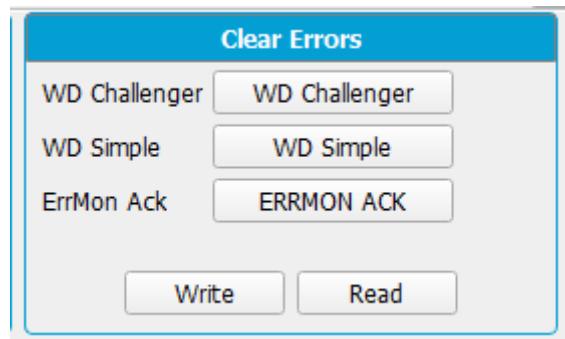
To release safety outputs step by step, continue with these instructions:

1. Configure WD window. Since it is not possible to send a WD refresh periodically, Open WD Window. From FS config tab, go to WD window box, select INFINITE window, and then click **Write**.



Or from device manager select Open WD Window script, and then click **execute**.

2. Send one good WD refresh to move on the state machine. From FS Config tab, click WD challenger or WD simple one time.

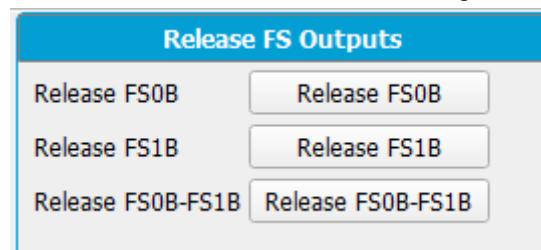


Or execute it from script editor or device manager.

3. Send the number selected good WD refresh to clean the Fault error counter. Example: default number is 6. Click six times on WD Challenger or WD simple button. Verify that the Fault error count is now 0 (FLT_ERR_CNT) in FS config tab.
4. Exit debug mode. Write 1 to exit debug mode bit in FS_STATES. Go to register map, then to safety tab.



5. Send "FS0b release" or "FS0b and FS1b release" command to move to normal mode. You can find these buttons in FS config tab.

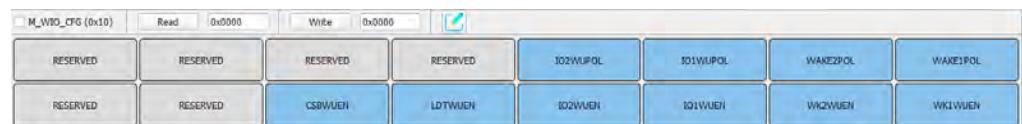


6. After these steps, device should move to Normal mode. To verify current state, click FS states display from USB and device status bar.

FS_STATES : 11-Normal

8.9 Low power mode

Once in INIT FS or Normal mode, select a way to exit the low power modes. Write 1 to the event or events that can wake the product from the low power modes.



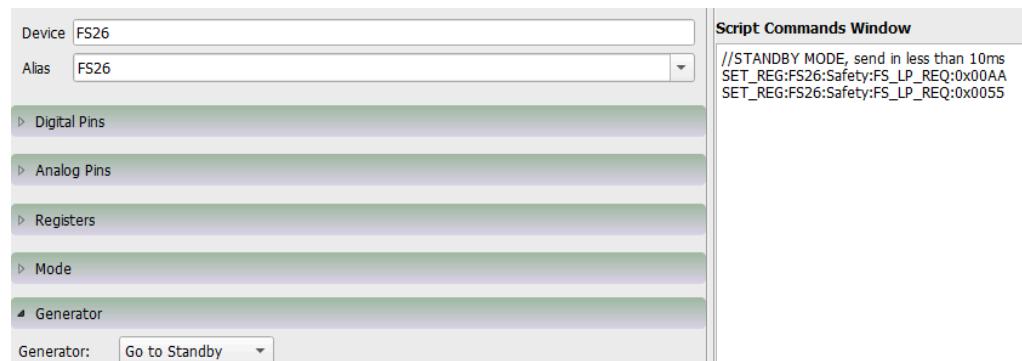
8.9.1 Go to standby

Execute Go to Standby script from device manager.



Or from Script editor → Generator, select Go to Standby script and run it.

Device should go to standby mode. Only VPRE stays turn On and LDOs as configured.

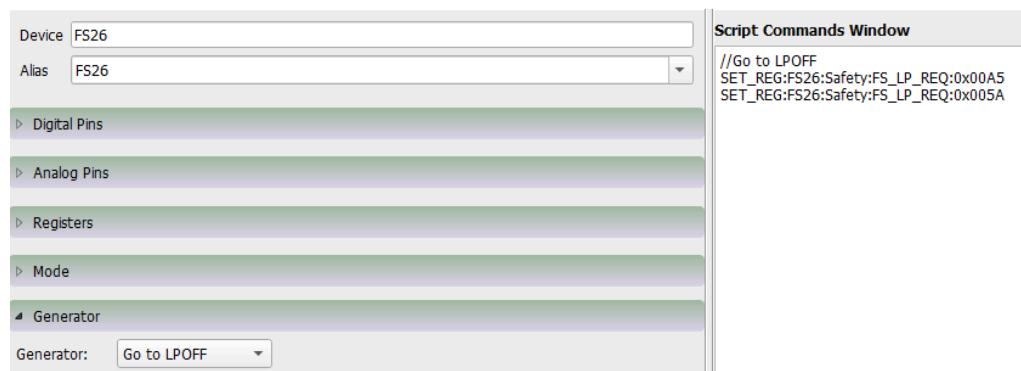


8.9.2 Go to LPOFF



Once in INIT FS or Normal mode, execute Go to LPOFF script from device manager. Or from Script editor → Generator, select Go to LPOFF script and run it.

Device should go to LPOFF mode. Only VPRE stays turned On.



9 Revision history

Revision history

Rev	Date	Description
v.1	20210129	Initial version

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